

# Applied (High Temperature) Superconductivity

## Academic Training Lecture 4

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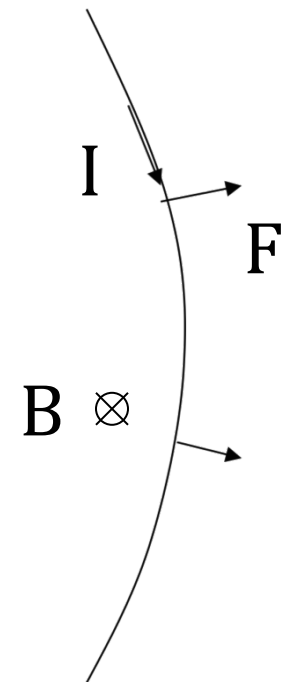
CERN/Geneva  
June 25-29, 2012

# Outline for the week of training

- Lectures 1& 2: Introduction & “Just enough” physics
  - Brief introduction ... what is superconductivity and why is it useful?
  - Basic physics of superconductivity and the superconducting state
  - Applications-relevant physics of superconductivity
- Lecture 3: Technical superconductors
  - A brief summary of NbTi and Nb<sub>3</sub>Sn
  - HTS conductor options: Bi2212 & YBCO
- **Lecture 4: Electromechanical behavior**
  - A brief summary of NbTi and Nb<sub>3</sub>Sn
  - HTS conductor options: Bi2212 & YBCO
- Lecture 5: Quench behavior and high field magnets
  - What is quench protection?
  - Quench protection in HTS magnets

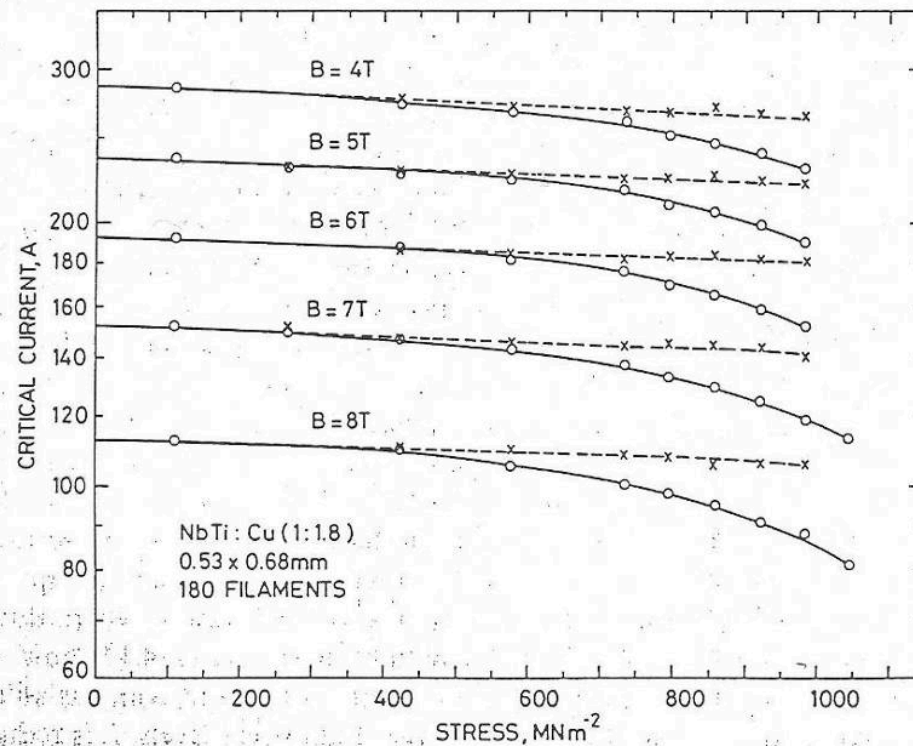
## Electromechanical behavior – why care?

- Pressure affects  $H_{c2}$  and  $T_c$  (and thus  $J_c$ )
- Sources of strain in magnets
  - Bending and possibly torsion during magnet construction
  - Differential contraction during cool down after processing
  - Lorentz forces during operation: single cycle and fatigue
  - Thermal cycling
  - Fault conditions
  - Cables add additional complexities
- What type of materials are superconductors?
  - NbTi: ductile metal
  - $Nb_3Sn$ : brittle intermetallic
  - Bi2212: brittle, micaceous ceramic w/ porosity & multiple secondary phases
  - YBCO → brittle but dense ceramic, deposited on high strength, ductile metal



## Electromechanics of NbTi

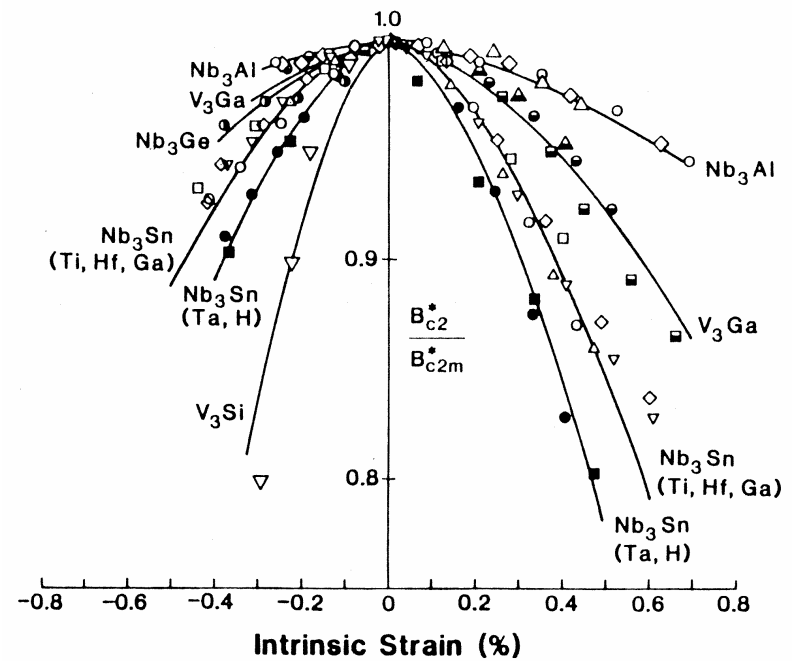
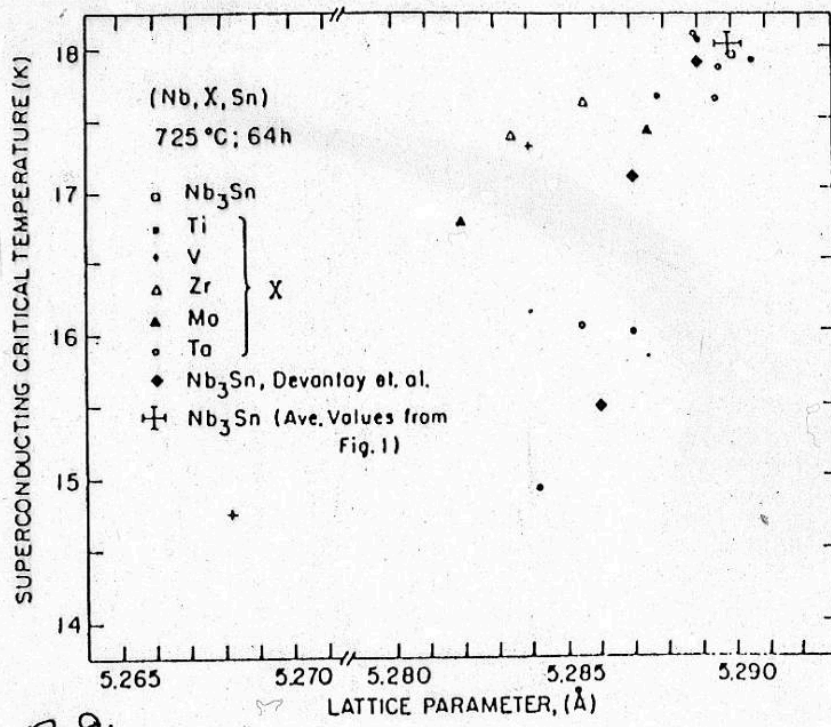
- Strain effects are largely reversible up to 2%, at which point the filaments break
- Composite behavior close to “rule of mixtures” combination of Cu and NbTi filament behaviors



# Electromechanics of Nb<sub>3</sub>Sn

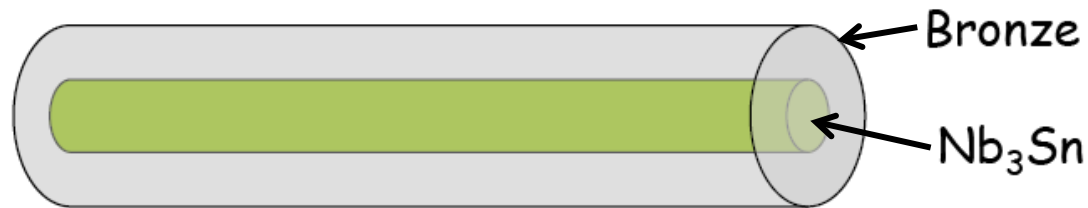
- Nb<sub>3</sub>Sn sufficiently brittle that all magnets are “wind & react” → heat treatment is “last step”
- Lattice parameter changes (reversible) affect T<sub>c</sub> & H<sub>c2</sub>
- Microcracking & fracture (irreversible)
- Plastic deformation of matrix (Cu or bronze)

# Effects on critical properties $Nb_3Sn$ & other A15s



## Pre-compression (of Nb<sub>3</sub>Sn)

- Composite of bronze and Nb<sub>3</sub>Sn is processed at high temperature  $\approx 700$  C (1000 K) then cooled to 4.2 K for operation

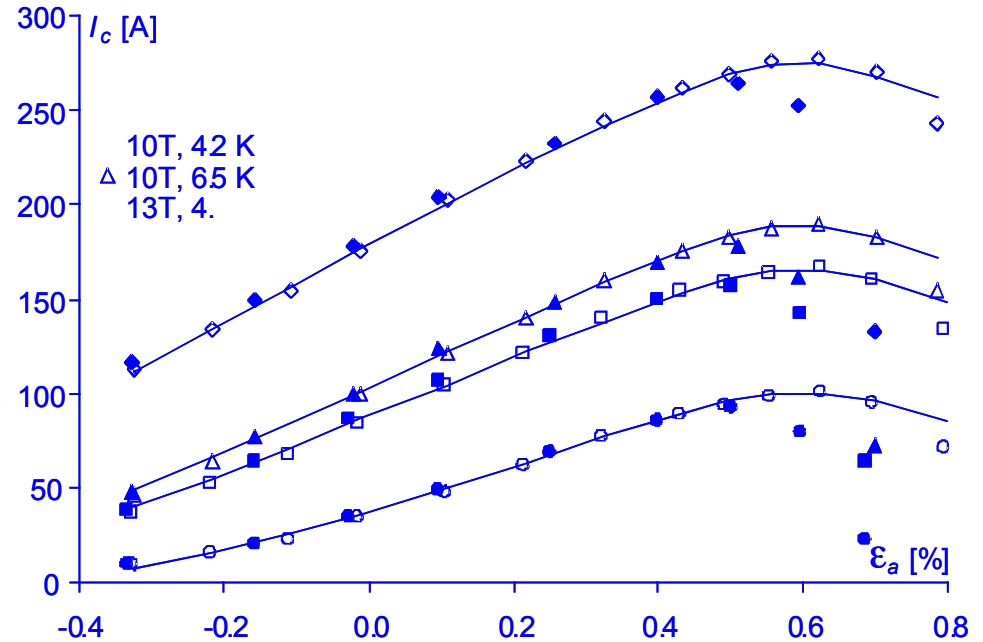
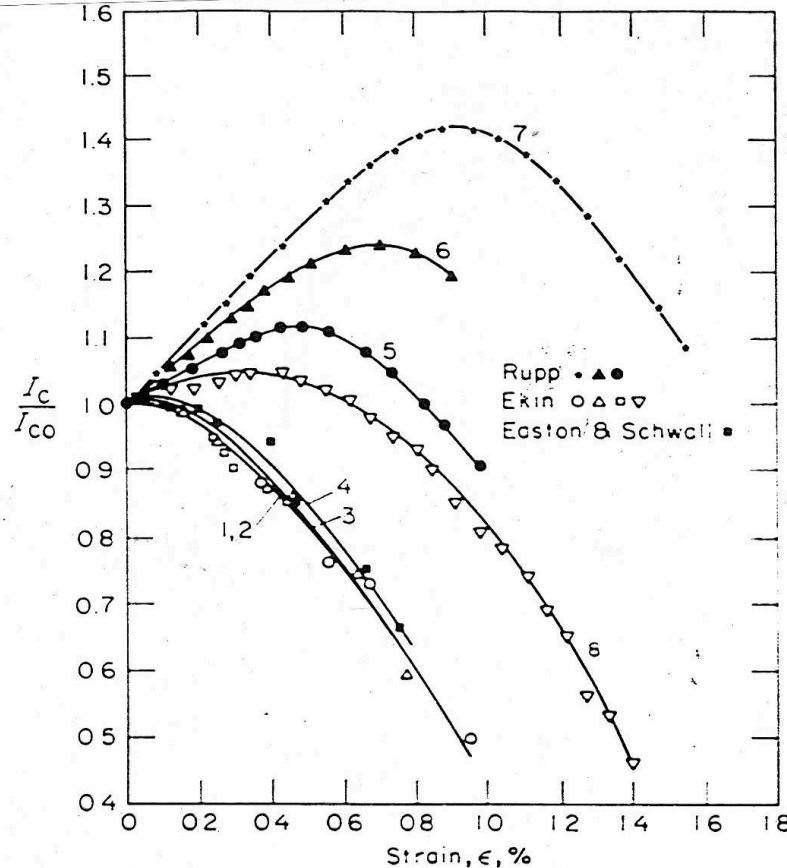


- Integrated thermal contraction:

$$\sigma_{Nb_3Sn} = \underbrace{\left( \frac{\Delta L}{L} \Big|_{Nb_3Sn} - \frac{\Delta L}{L} \Big|_{Br} \right)}_{\approx 1\%} \left( \frac{E_{Nb_3Sn} E_{Br}}{EA_{Nb_3Sn} + EA_{Br}} \right) A_{Br}$$

# Effects of pre-compression

- Effect depends on Nb<sub>3</sub>Sn:metal ratio (Cu, bronze...)
- Pre-compression can be good for magnets





# ITER Nb<sub>3</sub>Sn cables

- Pre-compression varies with cable design
- Cross-over points in cables cause transverse pressure which can be problematic

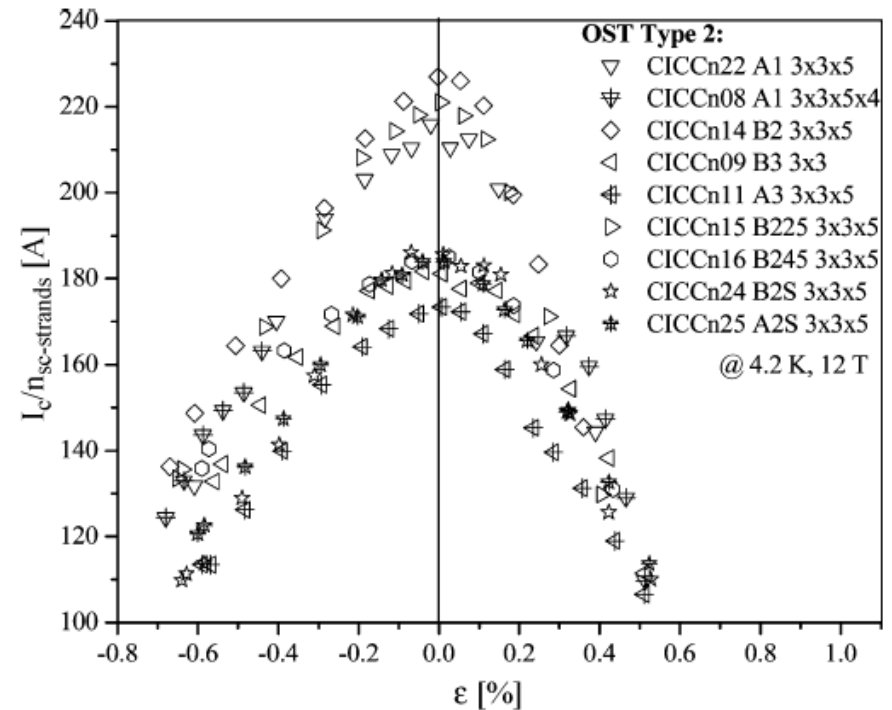
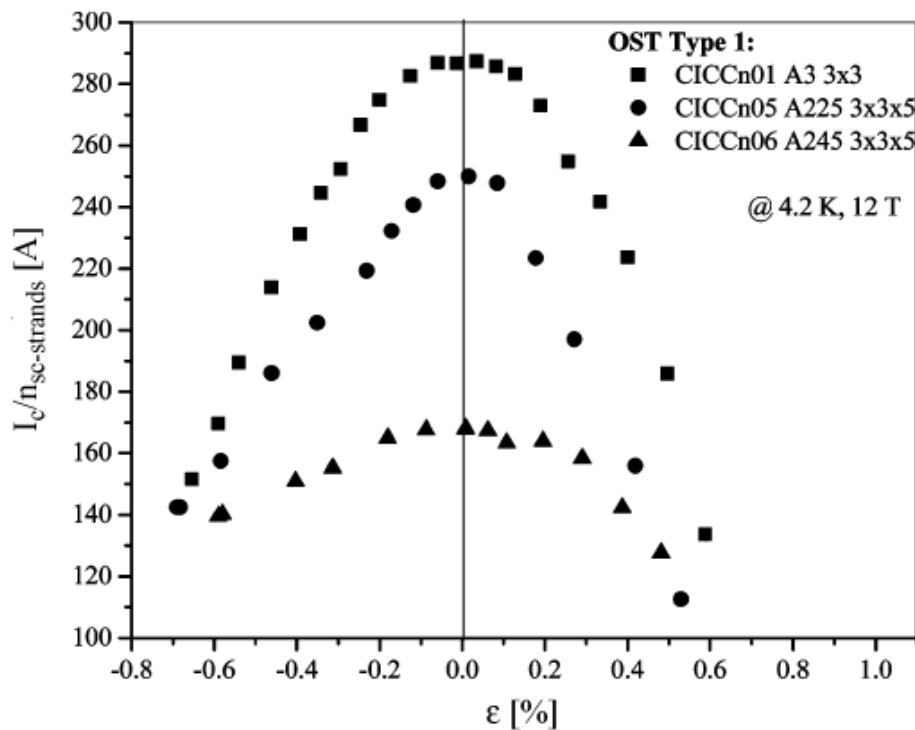


Fig. 4.  $I_c(\epsilon)$  for sub-stage CICC's manufactured from OST Type 1 strand measured at 4.2 K and 12 T.

Fig. 5.  $I_c(\epsilon)$  for sub-stage CICC's manufactured from OST Type 2 strand measured at 4.2 K and 12 T.

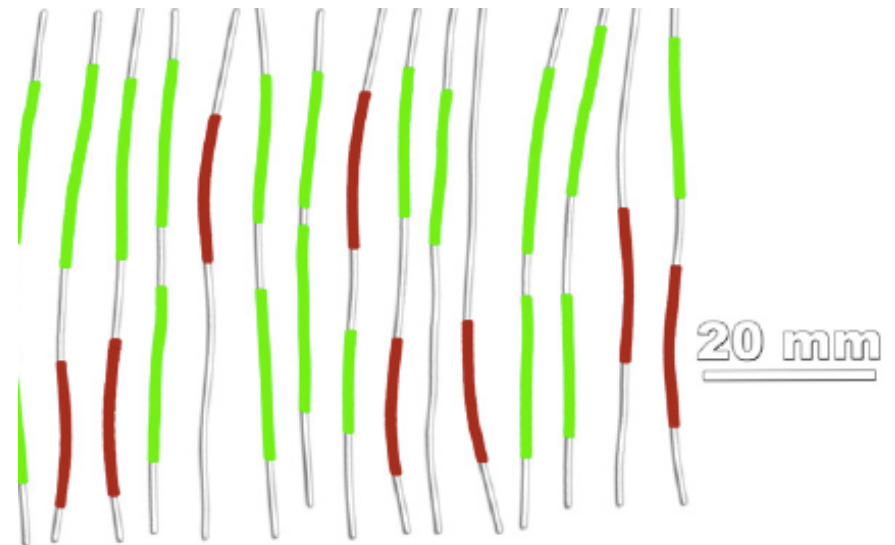
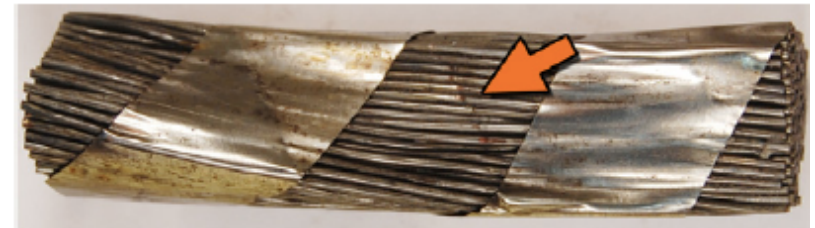
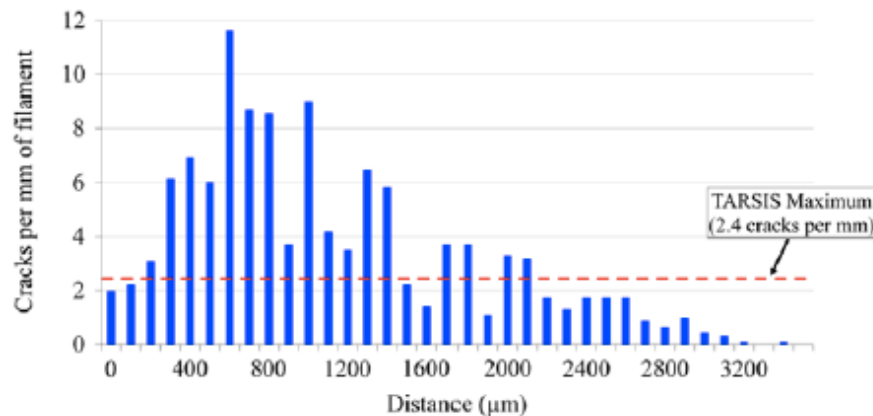
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## ITER cables show other problems can arise

- ITER studies have shown unanticipated results in CICC – degradation in  $Nb_3Sn$  not seen in NbTi
- Local filament fracture can be attributed to combinations of non-uniform loads leading to localized stress/strain variations



## Electromechanical behavior of HTS conductors

- One primary driver for HTS is high field, low T
  - Lorentz forces are particularly challenging
- Another driver is higher temperature, possibly low field applications for electrical/power systems
  - Will AC systems be fatigue limited?
- What do we know about YBCO & Bi2212?
  - Start with a look at statistics

# Weibull statistical analysis of HTS behavior

Statistics often used to analyze brittle materials

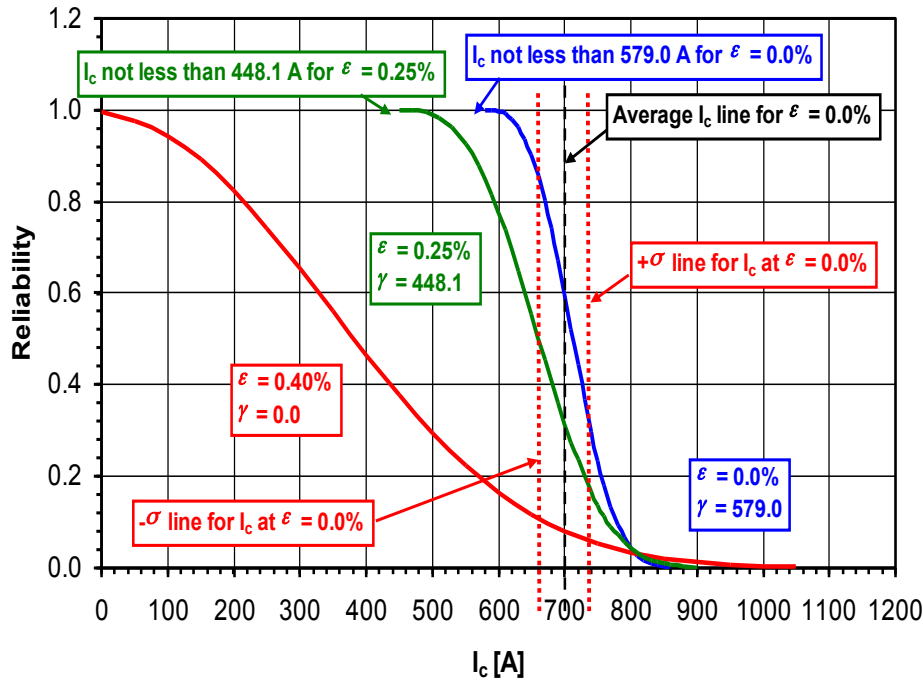
Three-parameter Weibull distribution function:

$$F(x; \alpha, \beta, \gamma) = 1 - e^{-\left(\frac{x-\gamma}{\alpha}\right)^\beta} : \alpha \geq 0, \beta \geq 0, \gamma \geq 0 \dots \dots \dots (1)$$

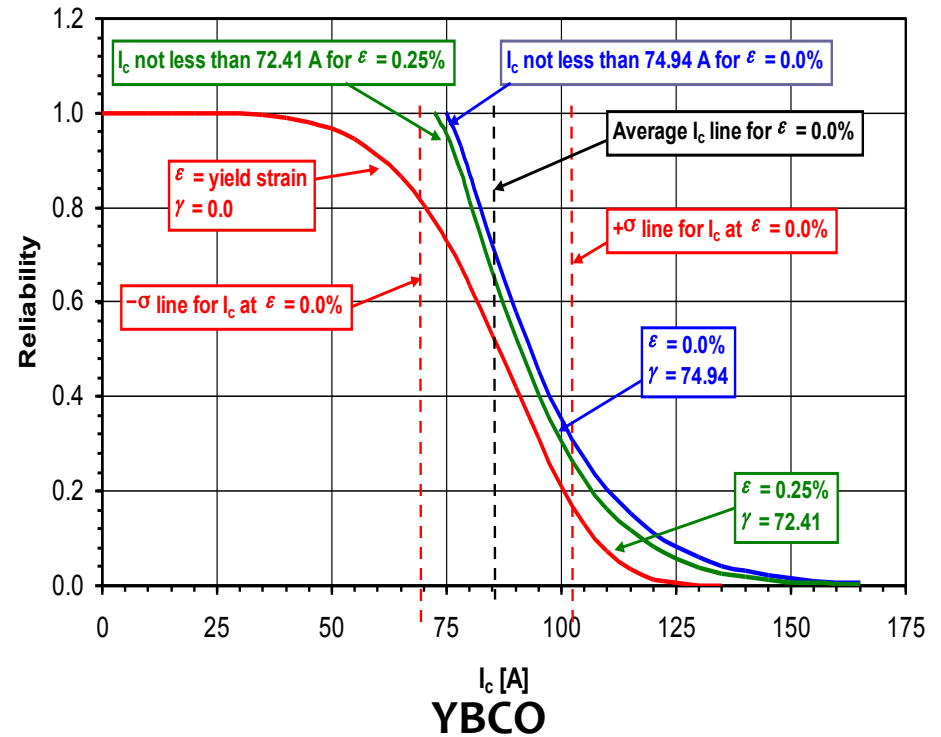
where  $\alpha$ ,  $\beta$  and  $\gamma$  are scale, shape and location parameters respectively.

- ☐ Measure: yield stress, Young modulus,  $I_c$  at strains ranging from  $\epsilon=0\%$  to yield
- ☐  $I_c$  test condition: 4.2 K, self-field for Bi2212; 77 K, self-field for YBCO
- ☐ Electric field criterion: 1  $\mu\text{V}/\text{cm}$
- ☐ 25 samples tested for each strain value

# Bi2212 wire v YBCO tapes reliability curves



Bi2212 round wires



YBCO

$\gamma(\epsilon)$  = zero-margin design limit

YBCO: indicative of metallic behavior at low/intermediate strain; ceramic-like at high strain

Bi2212: inhomogeneous, defect-dominated behavior

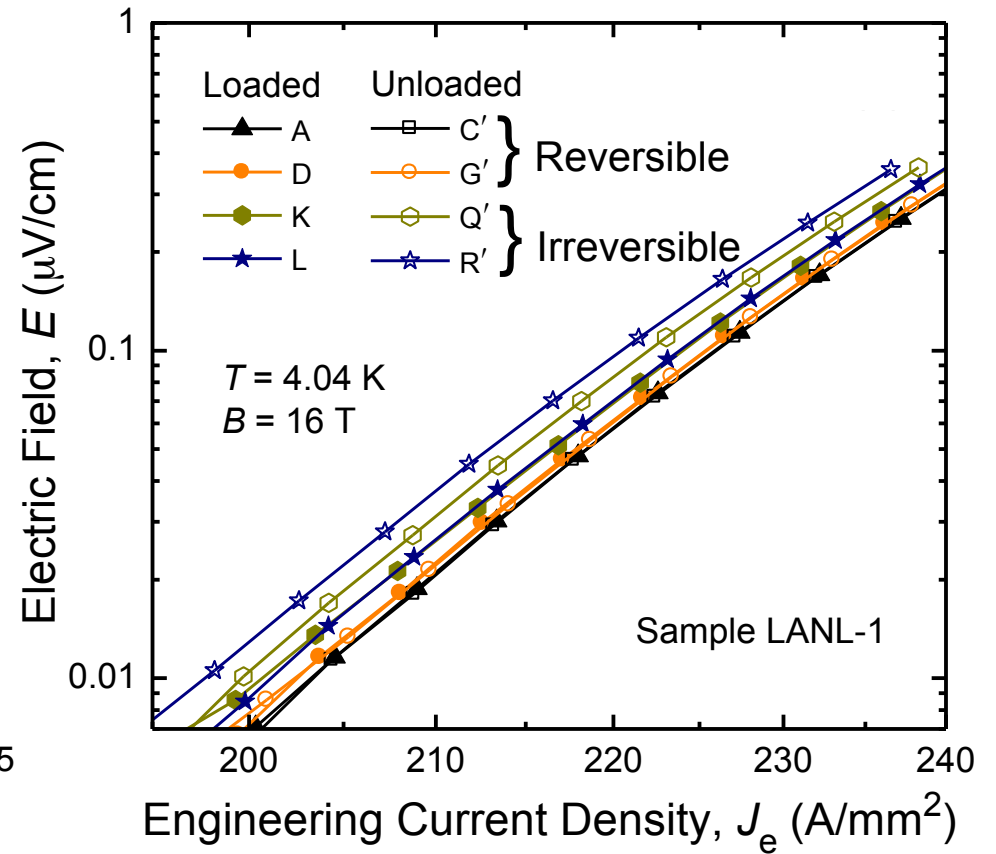
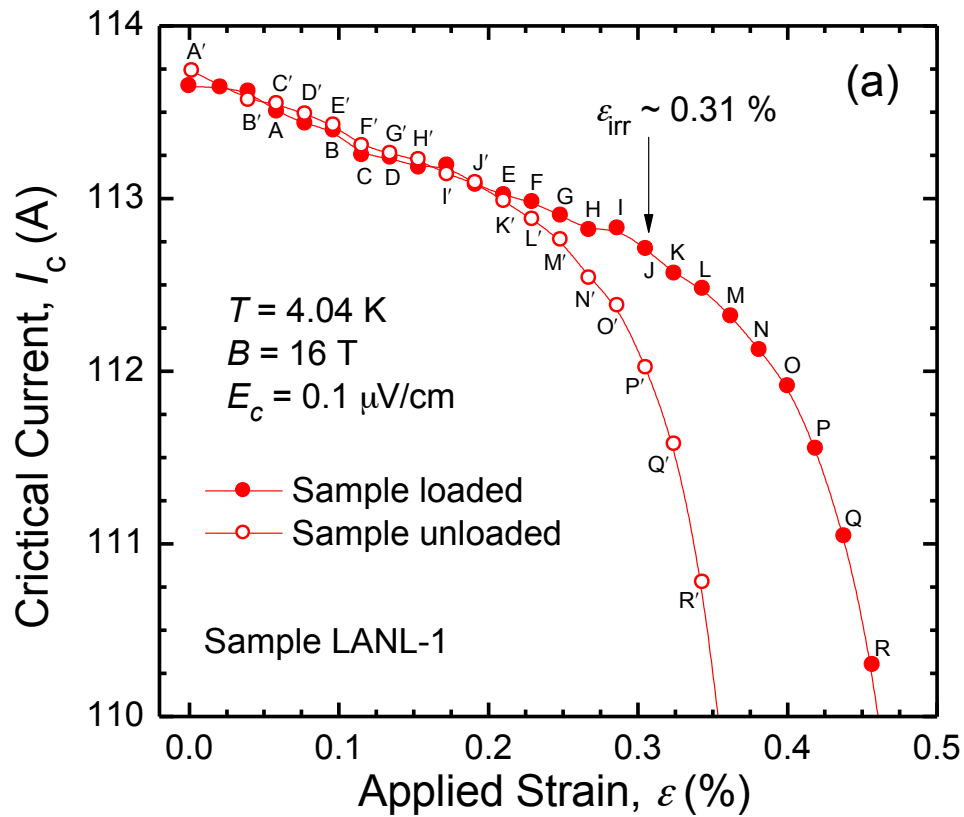
## Do Weibull statistics give some general meaning?

- YBCO axial tensile behavior dominated by Ni-alloy substrate and stabilizer
- Simple critical strain model does not fully capture tensile behavior for Bi2212, which acts like a ceramic
- Bi2212 has high-performing “tail” (high  $J_c$  “backbone”) that indicates potential for significant improvements

## Bi2212 electromechanics ... so what's new?

- Bi2212 wires have progressed with  $J_c$  increasing
- Timeliness of electromechanics important as well
- Recent studies by NIST (w/FSU & LANL) and Supercon/NCSU show new insights and potential for future improvements
  - Improvements through the Bi2212 filament
  - Improvements through the sheath material
- Questions:
  - Is Bi2212 behavior reversible?
  - Can new sheaths make a difference?

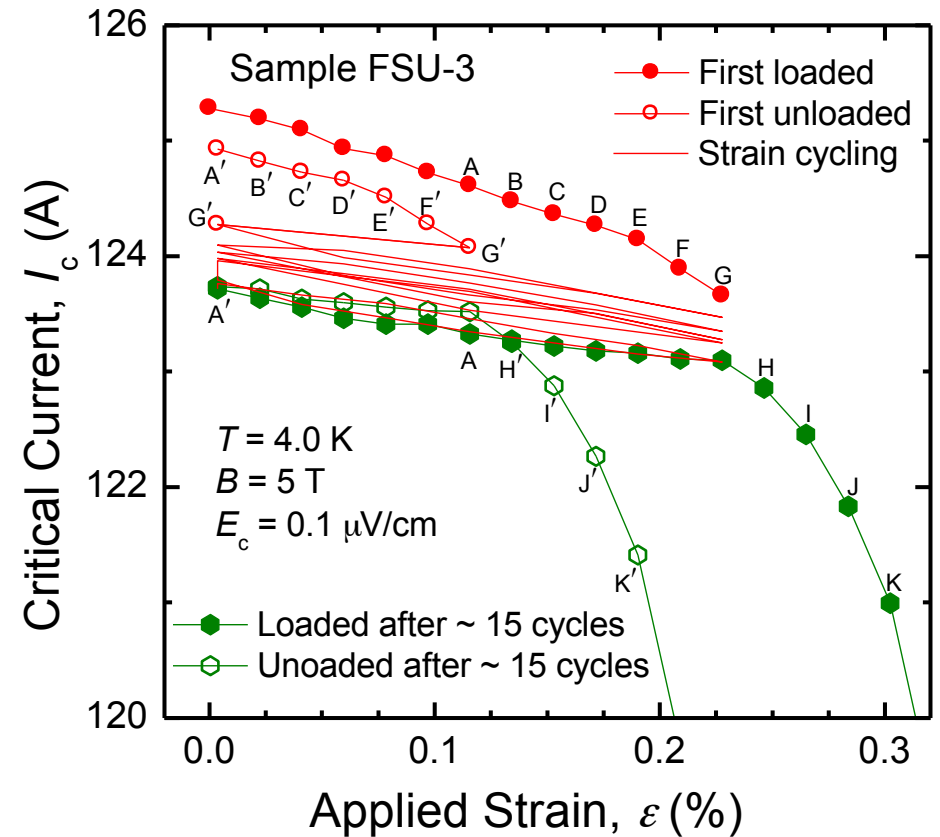
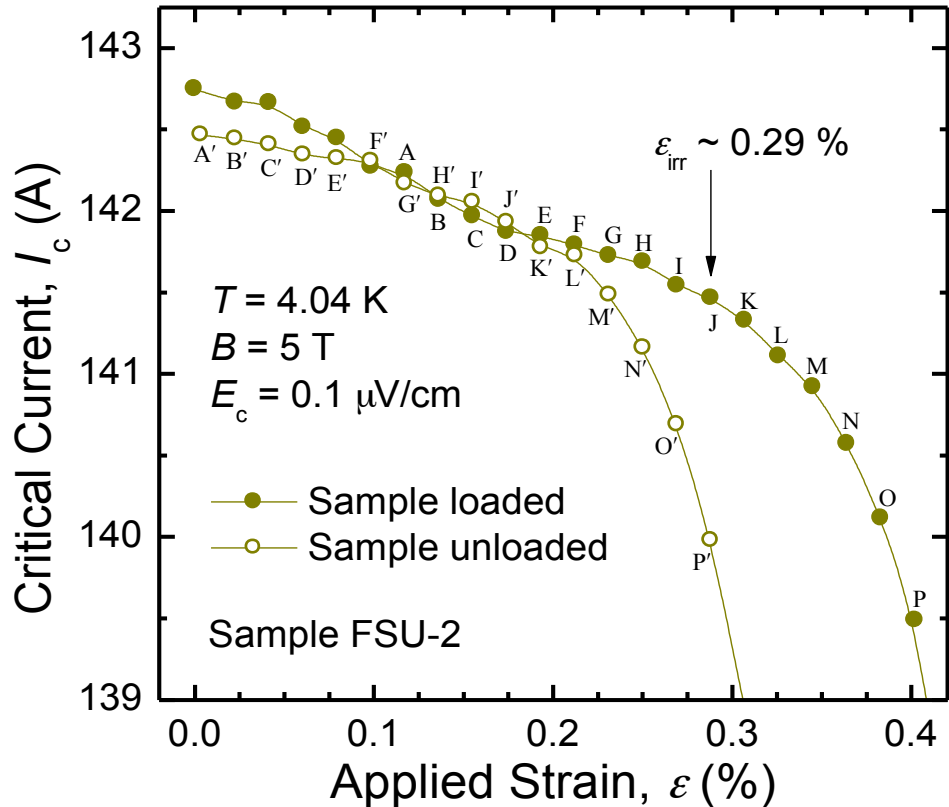
# Reversible behavior in Bi2212 wires



Cheggour et al, SuST 2012



# But not always...



Reversibility not clear until strain is increased or cycled

Cheggour et al, SuST 2012

## Two-component model proposed

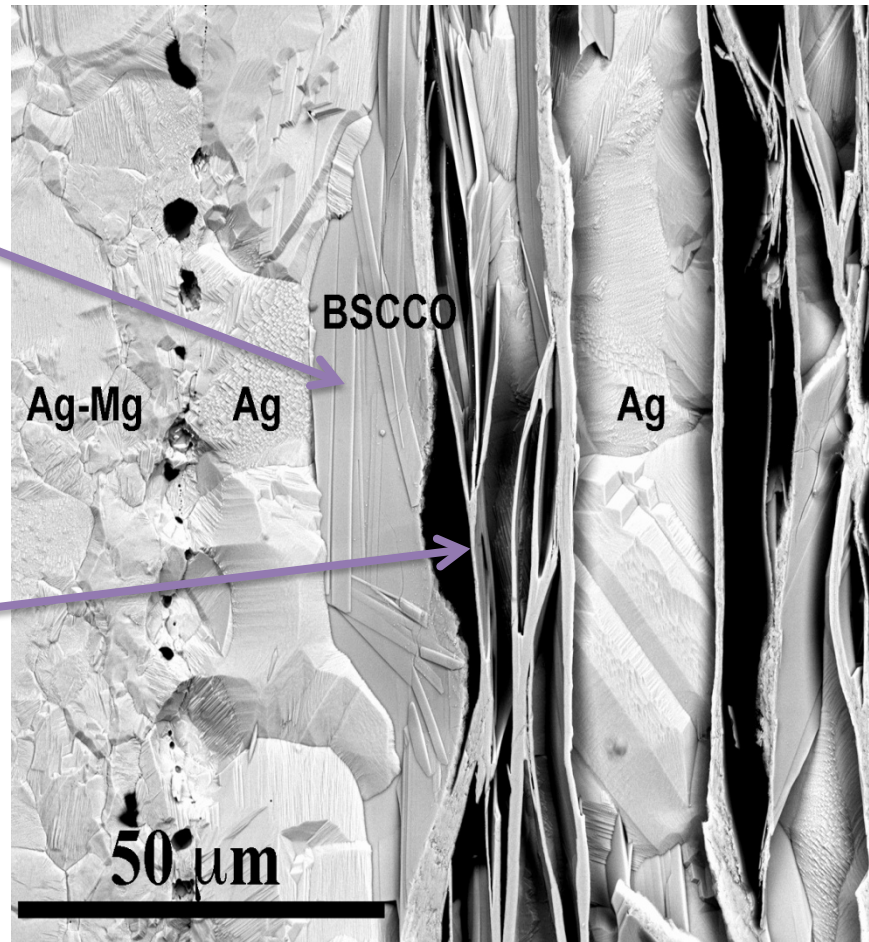
- Two “types” of Bi2212 within filaments; one mechanically weak and the other mechanically strong
- If weak component does not contribute to transport initially, then wire reversible
- If weak component contributes to transporting current initially, then irreversible behavior until this component fails mechanically due to strain or cycling
- Consistent with Weibull results as well

Cheggour et al, SuST 2012

# Microstructural analysis

“Strong”  
component

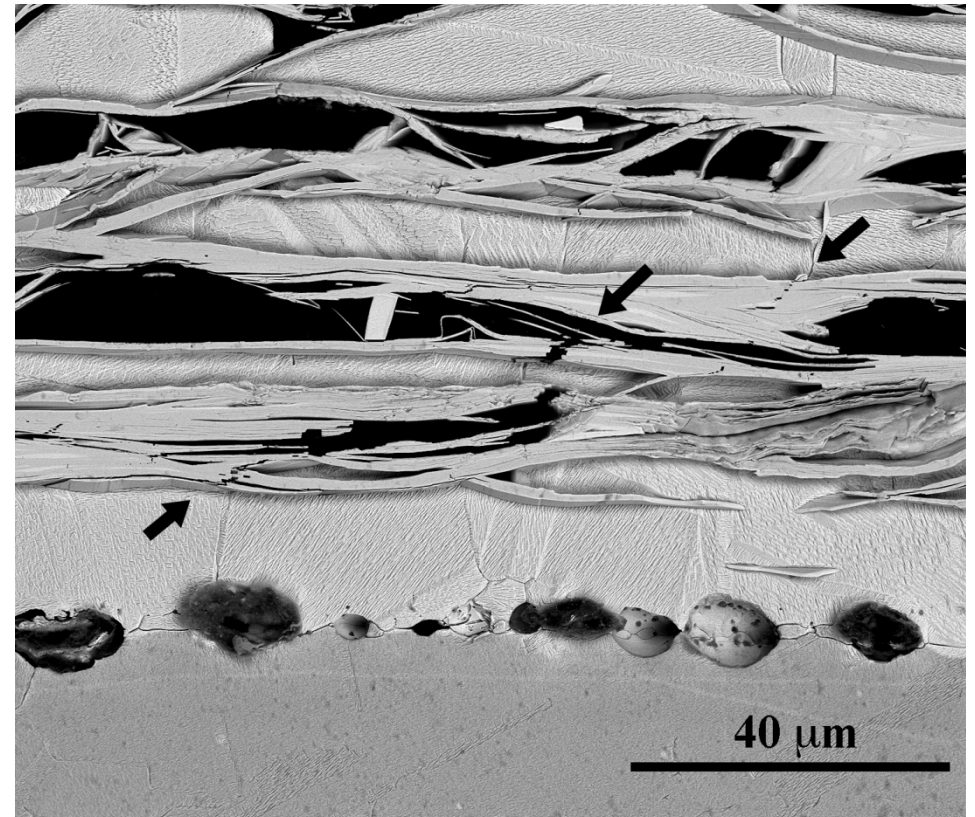
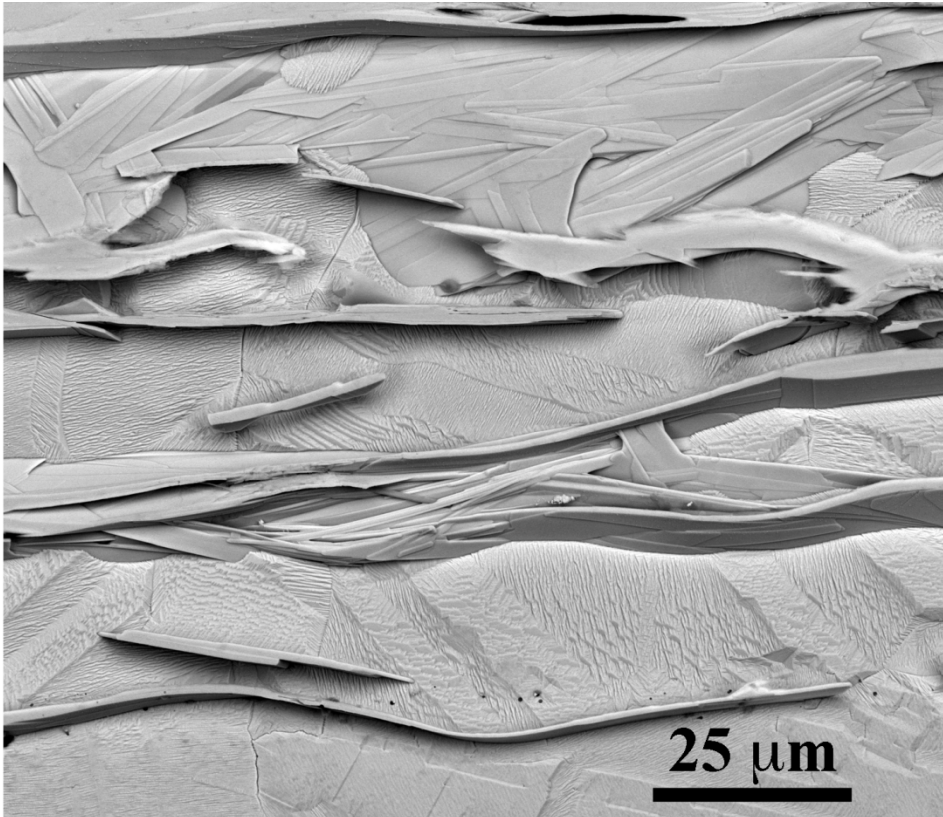
“Weak”  
component



Fibrous network of Bi2212 may be the mechanically *weak* component

# Microstructural analysis

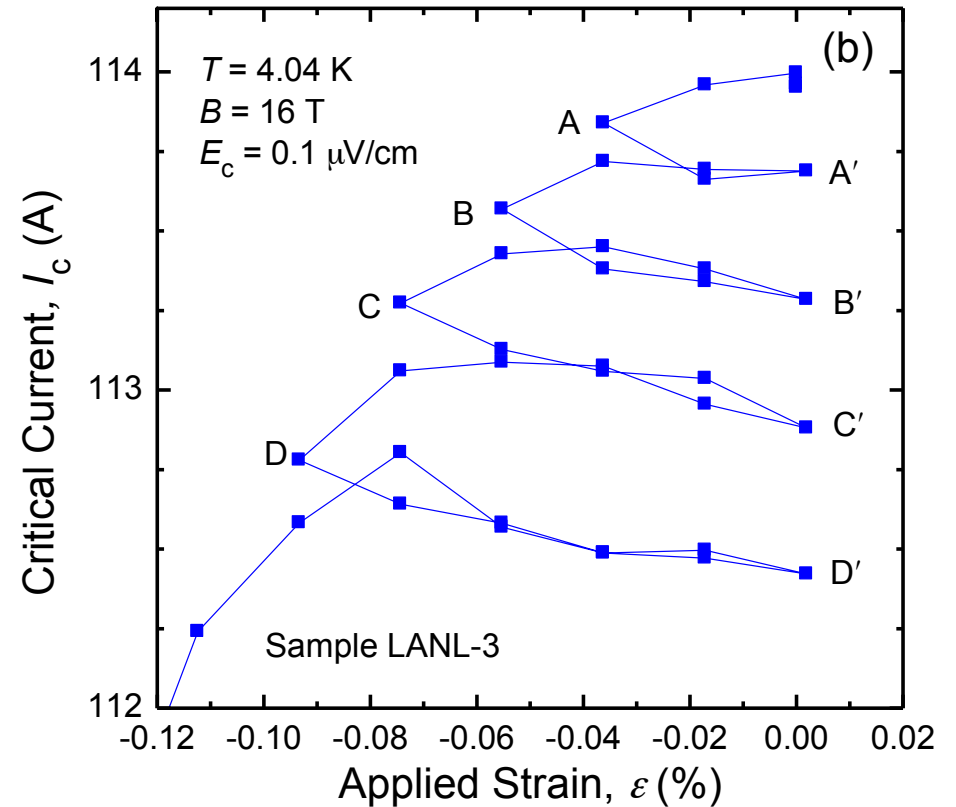
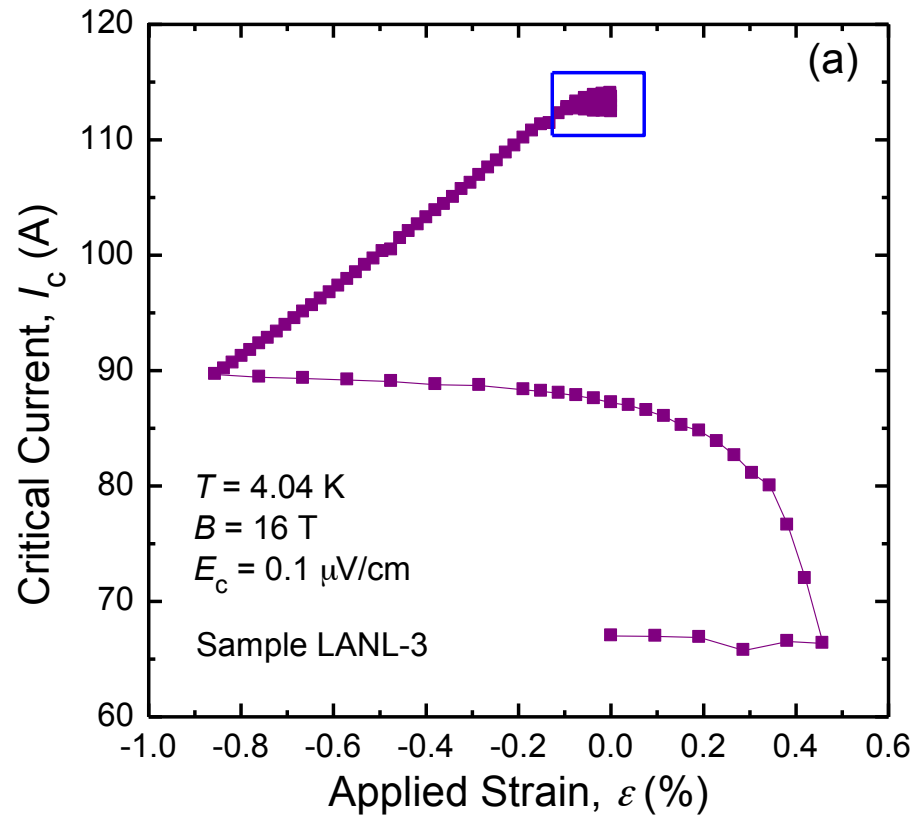
## Tensile strain



Cheggour et al, SuST 2012

Porosity may serve as crack nucleation sites

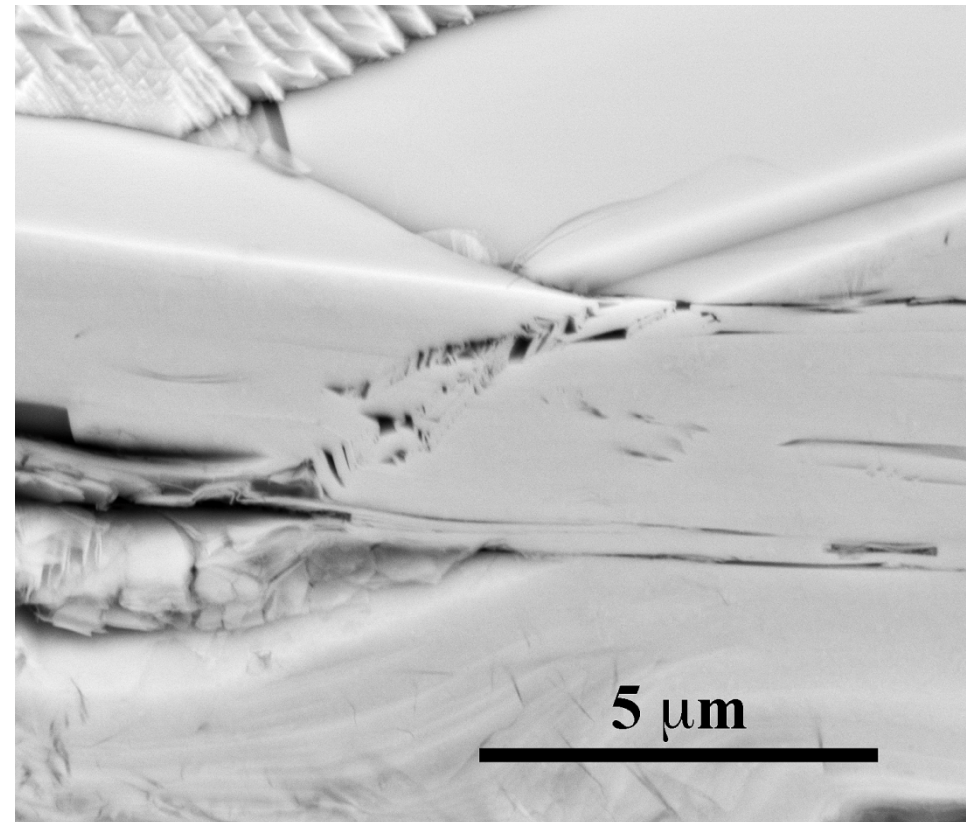
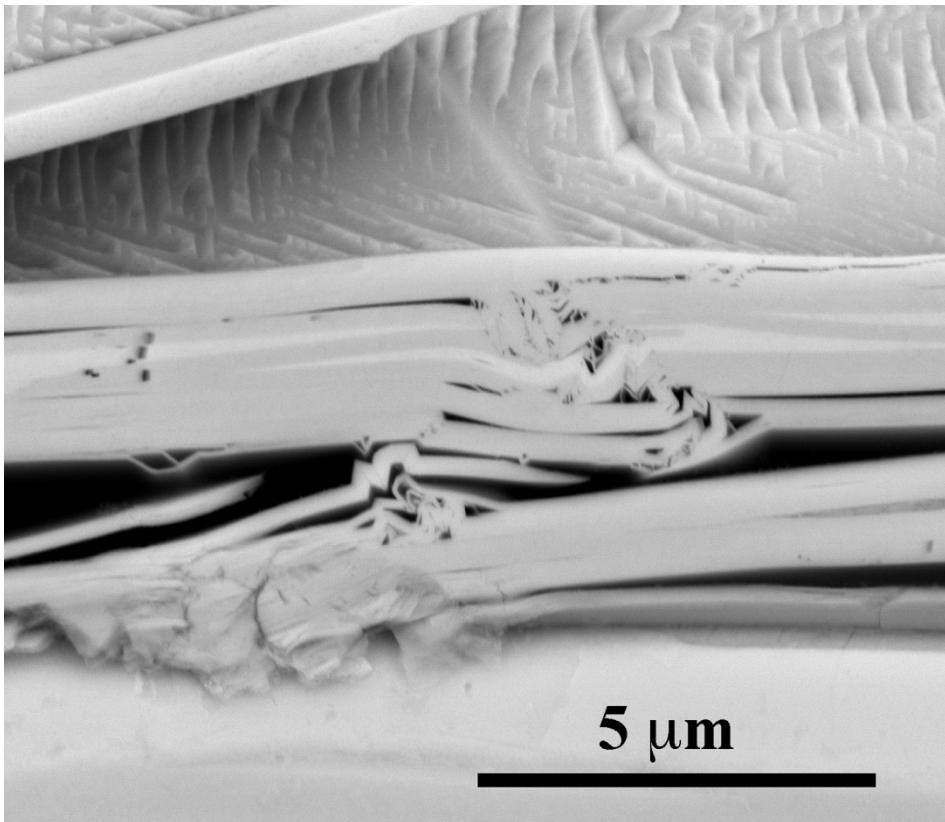
# What about compression?



No reversibility observed under axial compressive strain

# Microstructural analysis

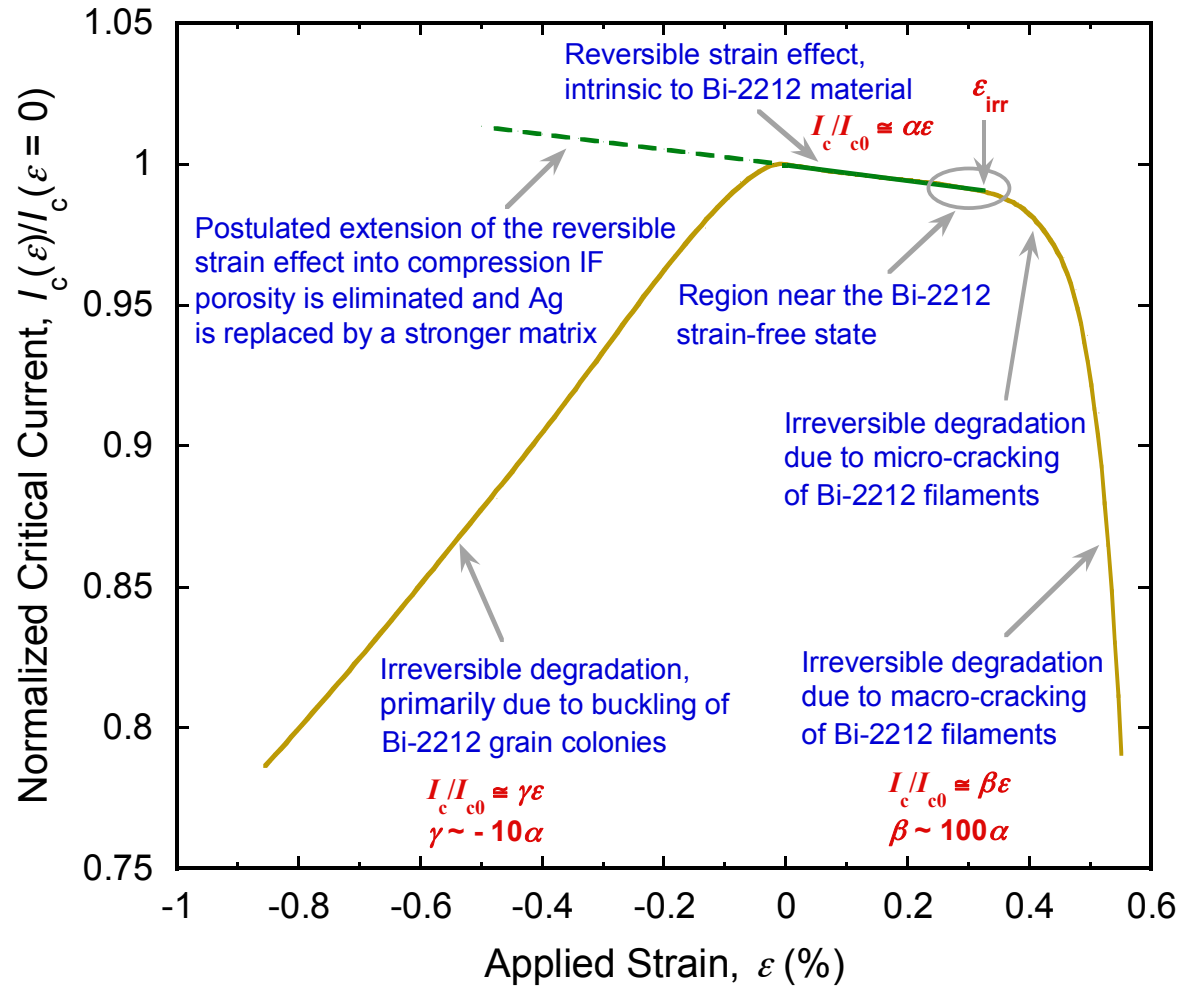
## Compressive strain



Cheggour et al, SuST 2012

Buckling may be at the origin of irreversibility

# Modified Descriptive Strain Model



Cheggour et al, SuST 2012

Lecture 4

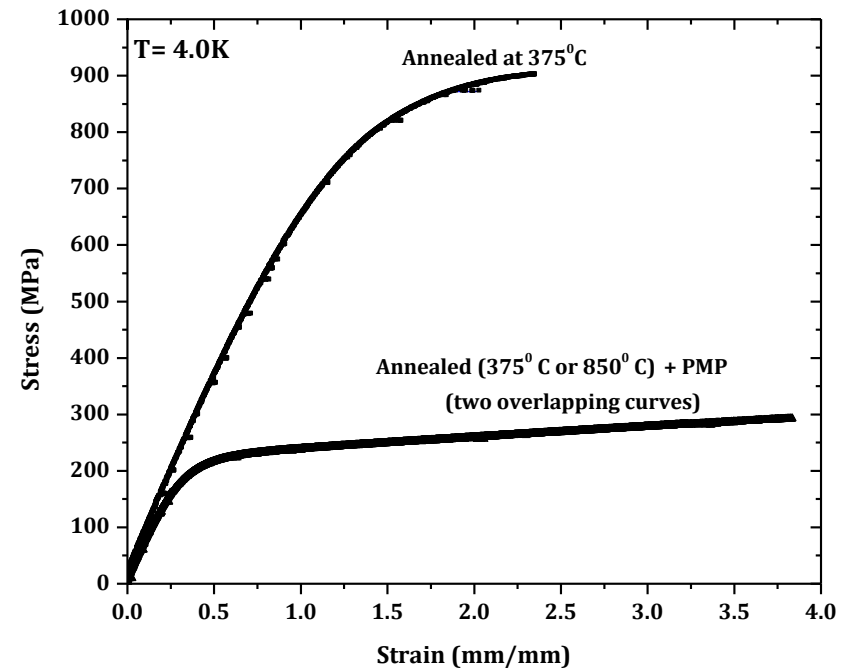
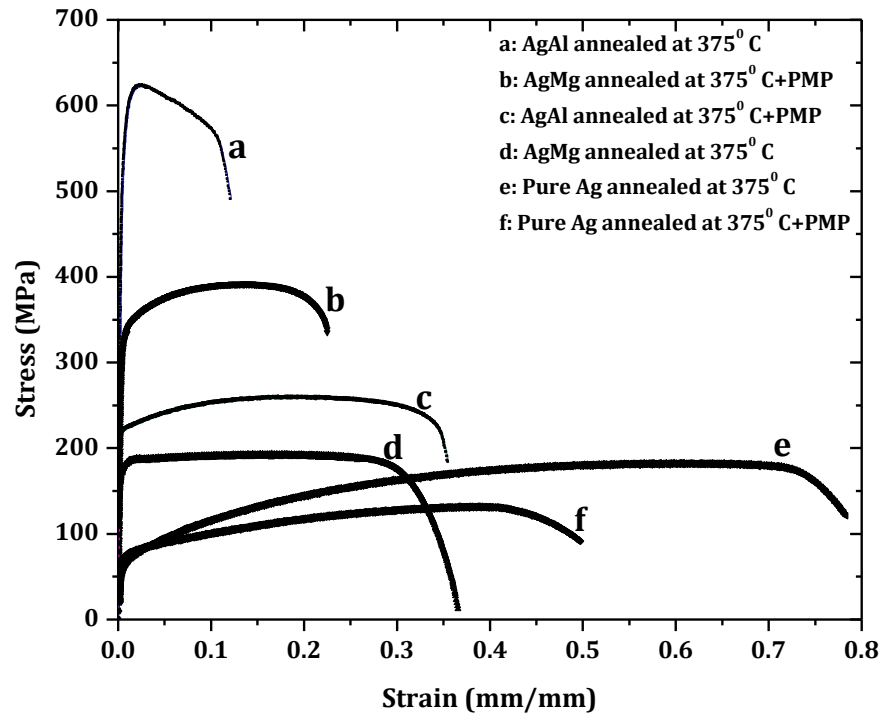
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## What about improved sheaths?

- AgMg has been used as outer sheath for over 20 years
- Cannot be adjacent to Bi2212 filament or  $J_c$  reduced
- Increased modulus and yield strength would improve Bi2212
- If compatible with filaments, then pure Ag can be eliminated
- Recent study of Ag/0.5wt%Al shows some promise

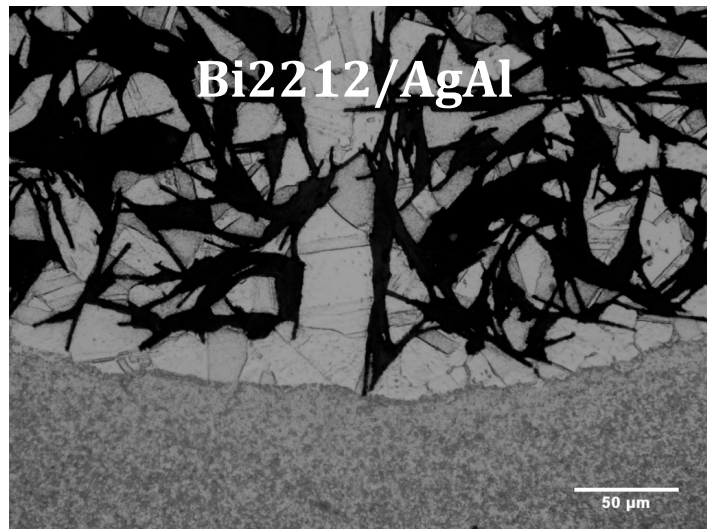
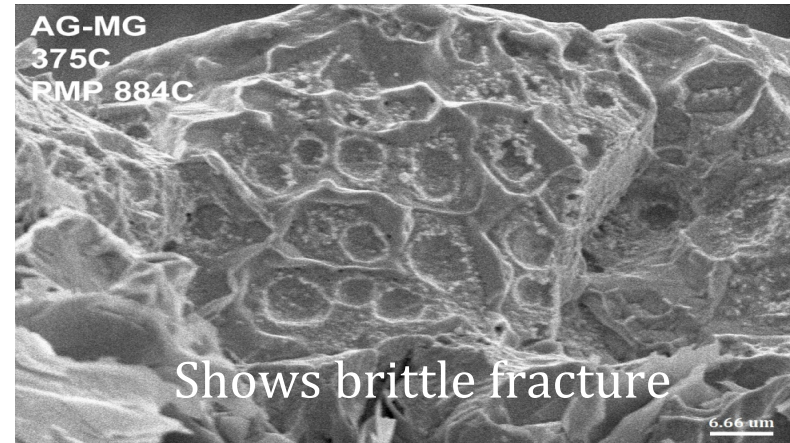
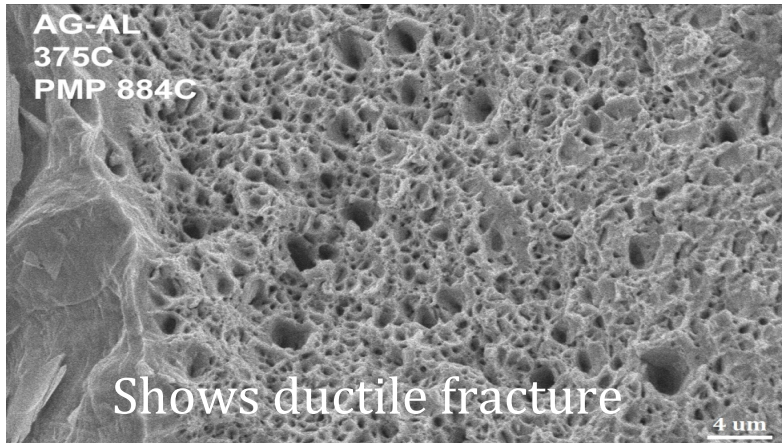


# $\sigma/\epsilon$ at room temperature and 4.0 K



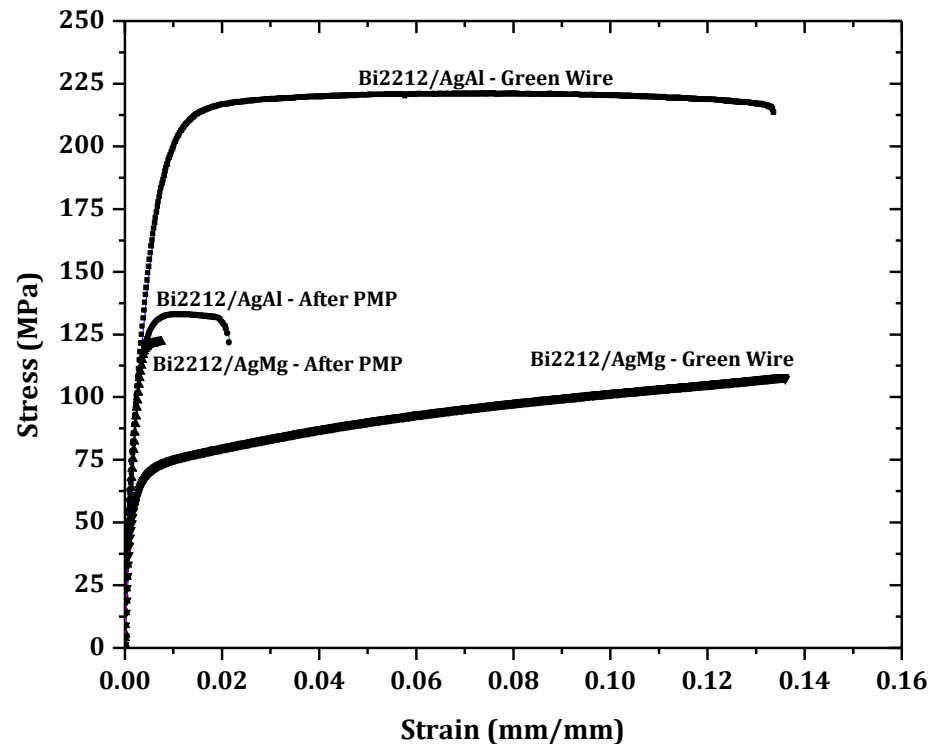
Kajbafvala et al. TASC 22 1 2012 8400210

# Fracture surface & grain structure comparison



# Room temperature $\sigma/\epsilon$ : Bi2212/AgMg and Bi2212/AgAl wire

Mechanical Parameters	Bi2212/ AgAl				Bi2212/AgMg			
	E(GPa)	YS (MPa)	UTS (MPa)	El%	E(GPa)	YS (MPa)	UTS (MPa)	El%
Green Wire	48	130	220	13.38	42	62.5	107	-
PMP Heat Treated	56	125	135	2.17	56	65	122	0.8



## $I_c$ measurements

- $I_c$  in AgAl wire higher than AgMg
- Chemical compatibility or effects of sheath mechanical properties? ... unknown ... but increased strength and  $I_c$  is a good start

<b>Conductor</b>	<b>Short samples</b>	<b><math>I_c</math> (A)</b>	<b>n - value</b>
<b>Bi2212/AgAl - HT1 (PMP)</b>	<b>w/out insulation</b>	<b>328</b>	<b>20.4</b>
	<b>with insulation</b>	<b>283</b>	<b>19.8</b>
<b>Bi2212/AgMg wire</b>	<b>w/out insulation</b>	<b>269</b>	<b>18.6</b>

# Electromechanics of (RE)BCO conductors

- Past 5 years has seen significant growth in studies of YBCO electromechanics (albeit mostly in LN<sub>2</sub>)
- Relatively low defect density in superconducting layer & high strength metallic sheath → sharp contrast to Bi2212
- YBCO layer is highly aligned and highly engineered ... so electromechanical studies are interesting for technology and science
- Ni-alloys give (RE)BCO intrinsic functional advantage

## Factors to consider that influence YBCO behavior

- Type of CC (grain orientation, morphology & size, ... )
- Direction of load relative to crystallographic axes
- Direction of applied magnetic field
- Degree of bi-axial texture & existing misalignment
- Effects of pressure on  $T_c$  &  $H_{c2}$  (and of  $T_c$  and  $H_{c2}$  on  $J_c$ )
- Pinning center types/geometry and relationship to magnetic field orientation
- Temperature-dependence of pinning center effectiveness
- Role of defects and imperfections
- Role of grain boundaries

Gets complex very quickly, and difficult to generalize details from one conductor to another

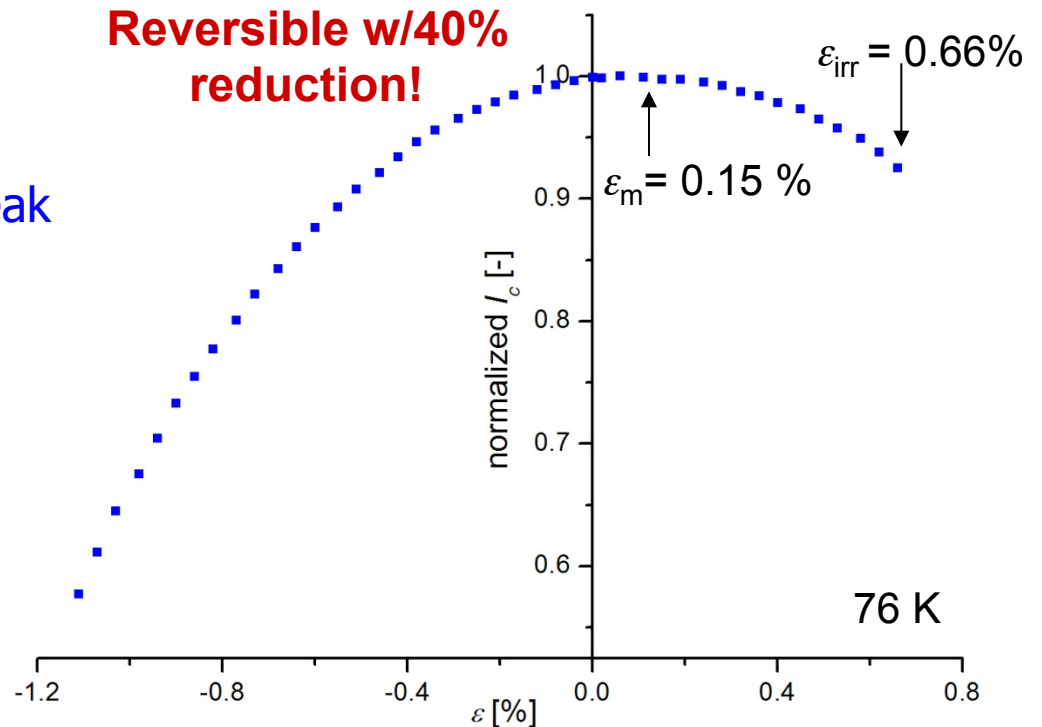
# Self-field $I_c$ -strain in YBCO CC (SuperPower IBAD)

$$I_c(\varepsilon)/I_c(\varepsilon_m) = 1 - a |\varepsilon - \varepsilon_m|^{2.2}$$

strain sensitivity      strain at peak

$\varepsilon_m$  is related to the initial strain state of the YBCO:

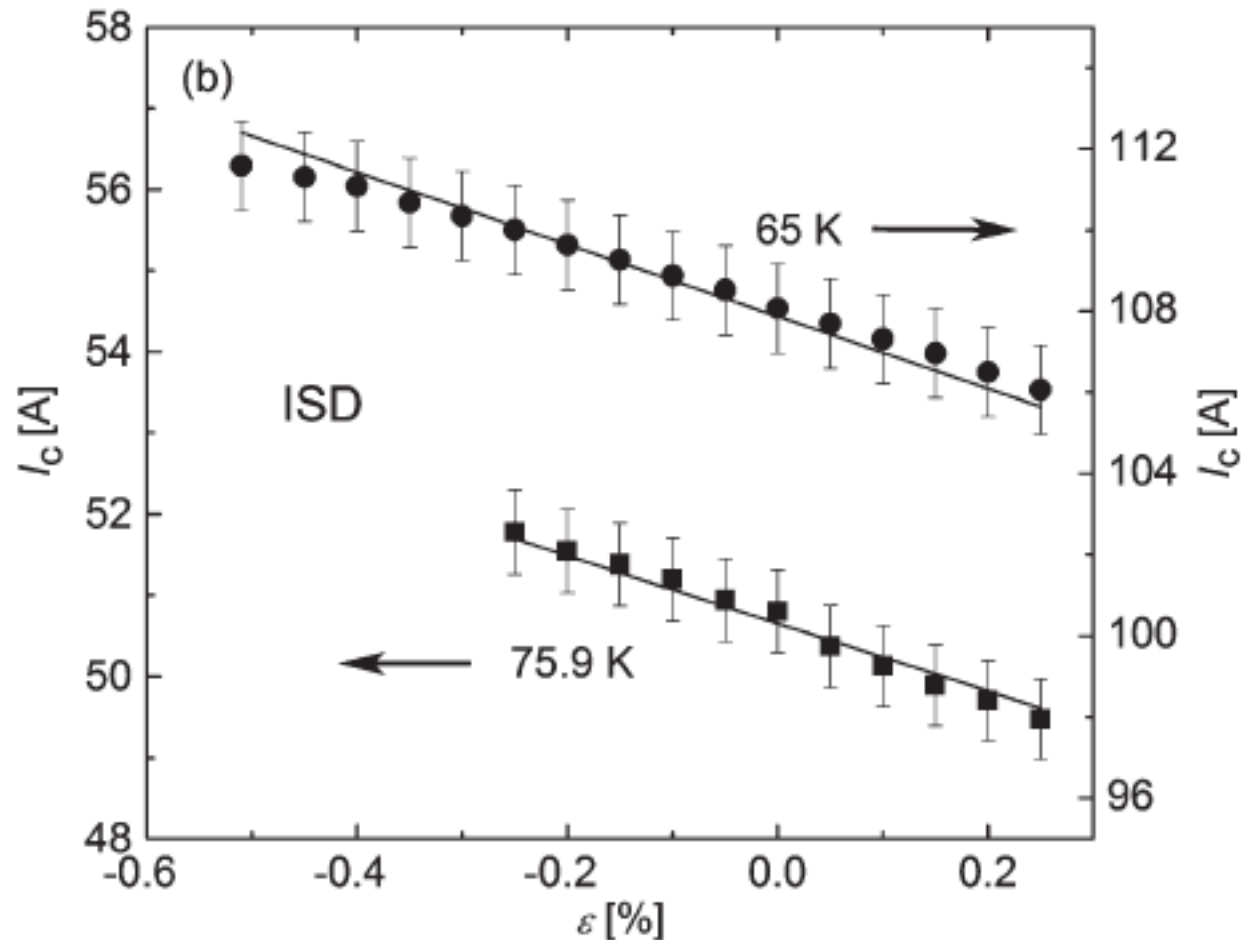
- thermal contraction
- lattice mismatch YBCO/buffer
- strain due to YBCO defects



D.C. van der Laan, *et al.*, *Appl. Phys. Lett.* **90**, 052506, 2007

# Same test – different conductor (ISD DyBa<sub>2</sub>Cu<sub>3</sub>O<sub>7-δ</sub>)

- Very different behavior

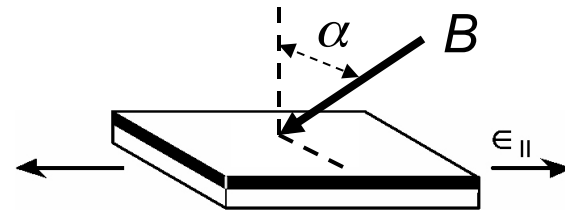




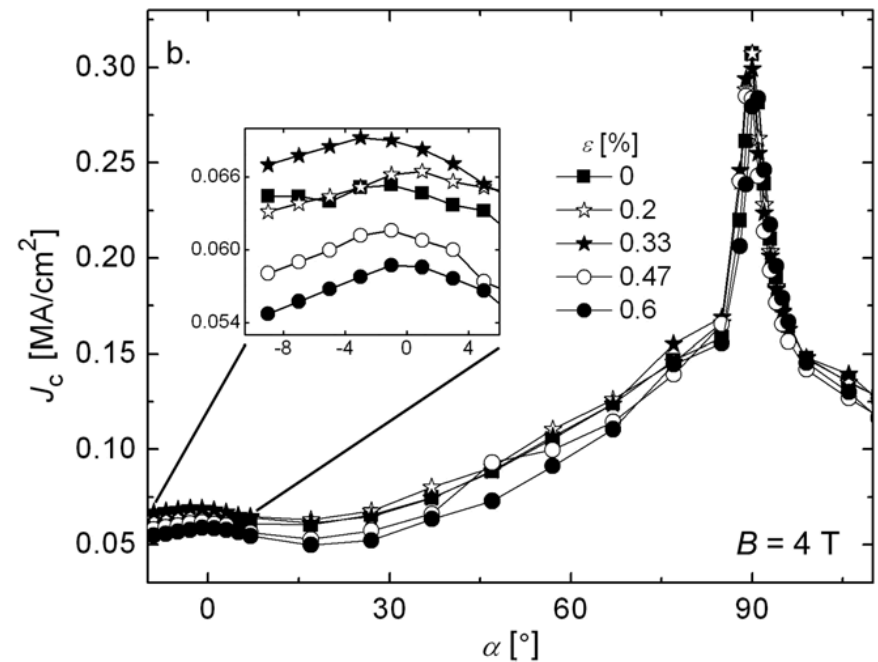
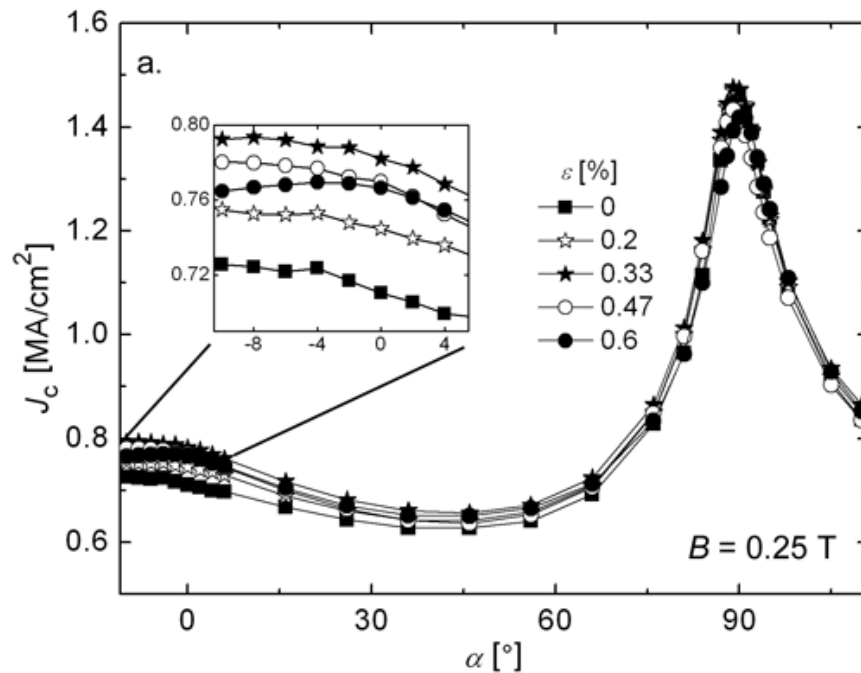
# What about in-field effects?

$$I_c(B, T, \varepsilon, \alpha)$$

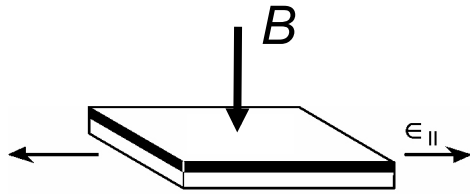
- strain  $\varepsilon$
- magnetic field  $B$
- field angle  $\alpha$
- temperature  $T$



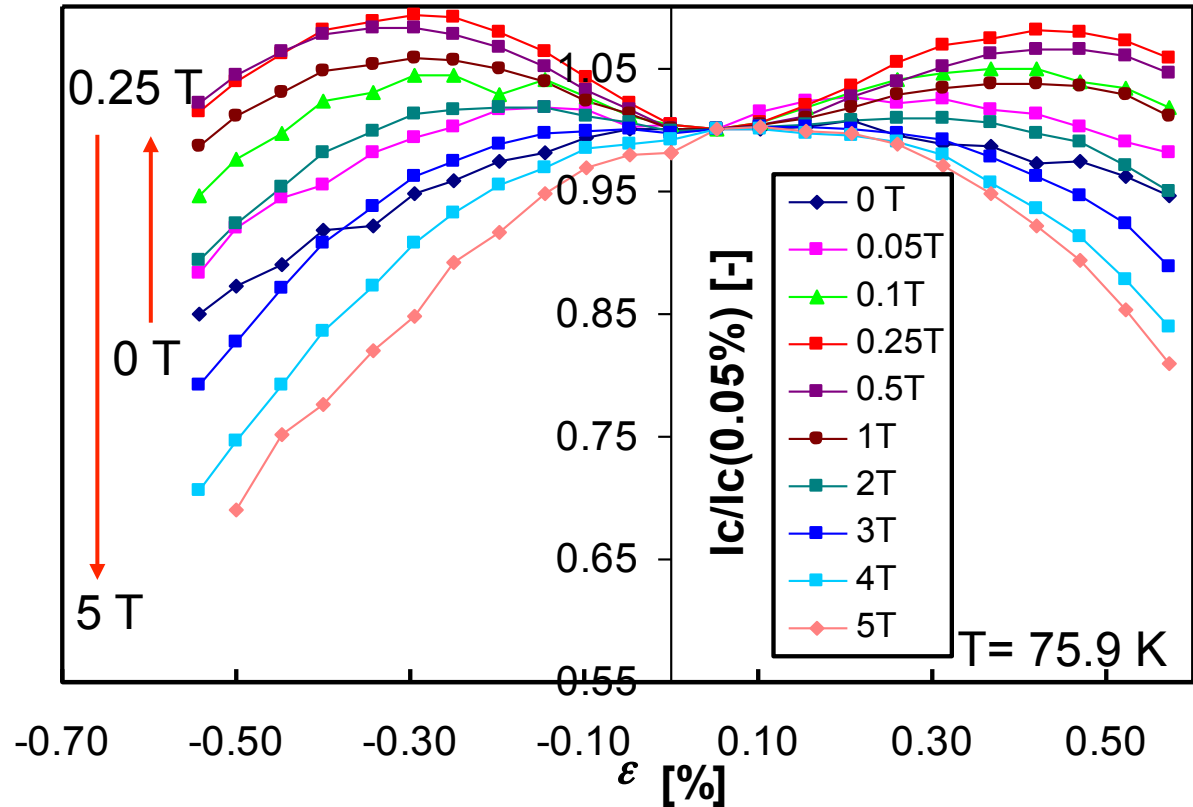
SuperPower IBAD: clearly a magnetic field dependence!



# $I_c(\epsilon, B)$ for $B \parallel c$ (SuperPower IBAD)



$I_c(\epsilon)$  normalized to its peak at  $\epsilon_m = 0.05\%$

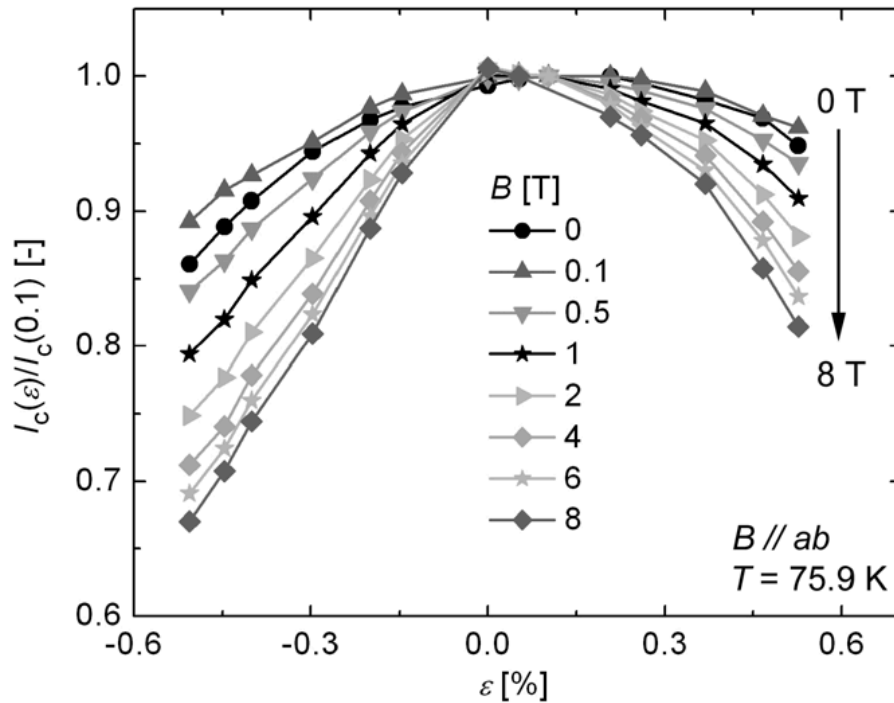
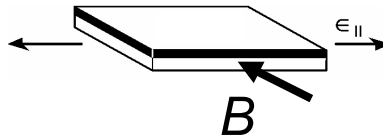


$I_c(\epsilon)$  with double maximum at low field.

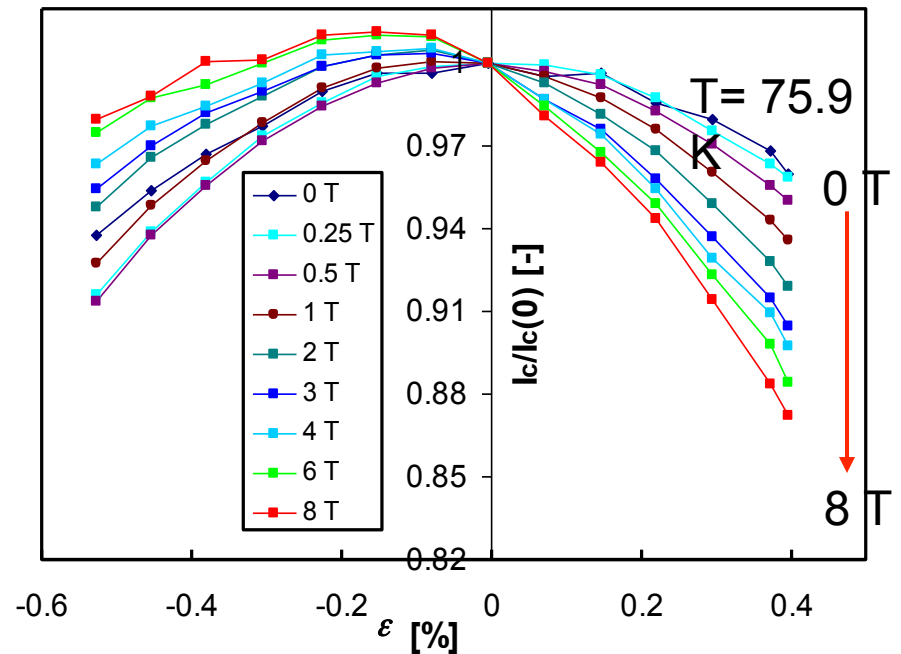
Different behavior between low- and high  $B$ : grain boundary role?

Strain sensitivity of  $I_c$  increases at high field.

# $I_c(\epsilon, B)$ for $B \parallel c$ (SuperPower IBAD & AMSC RABiTs)

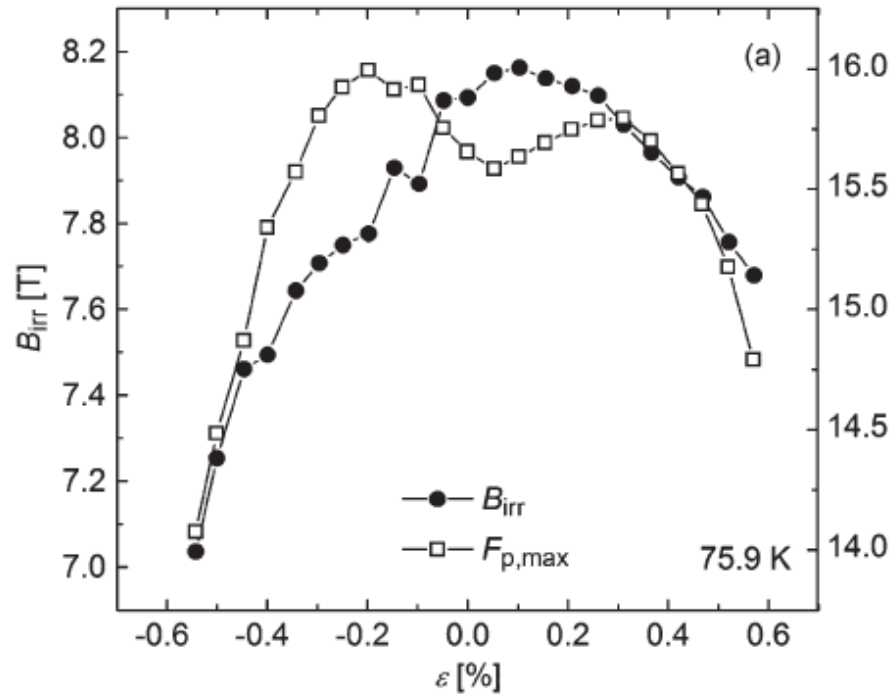


SuperPower IBAD

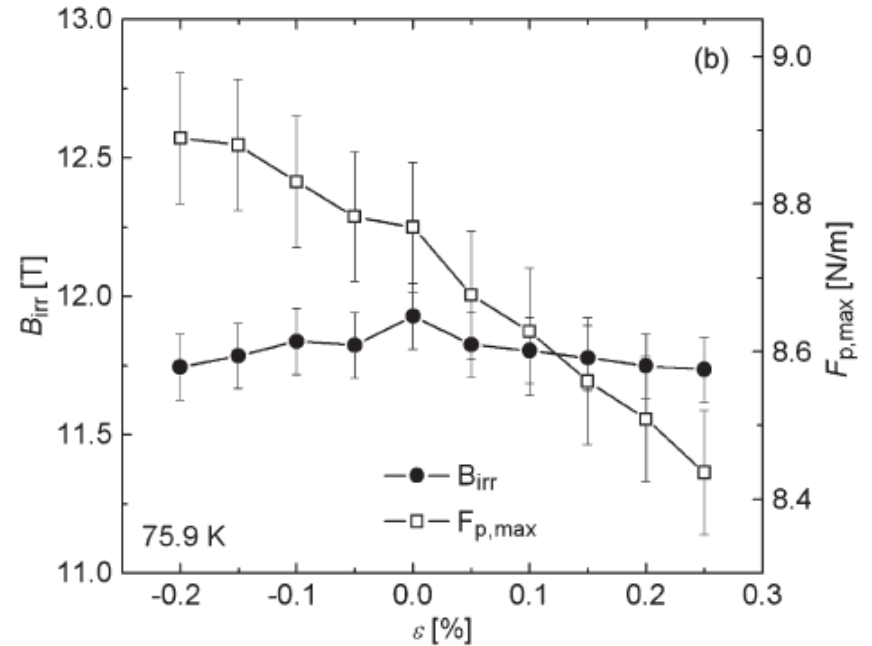


AMSC RABiTs

# Pinning force density and $H_{irr}$ (IBAD & ISD)



IBAD



ISD

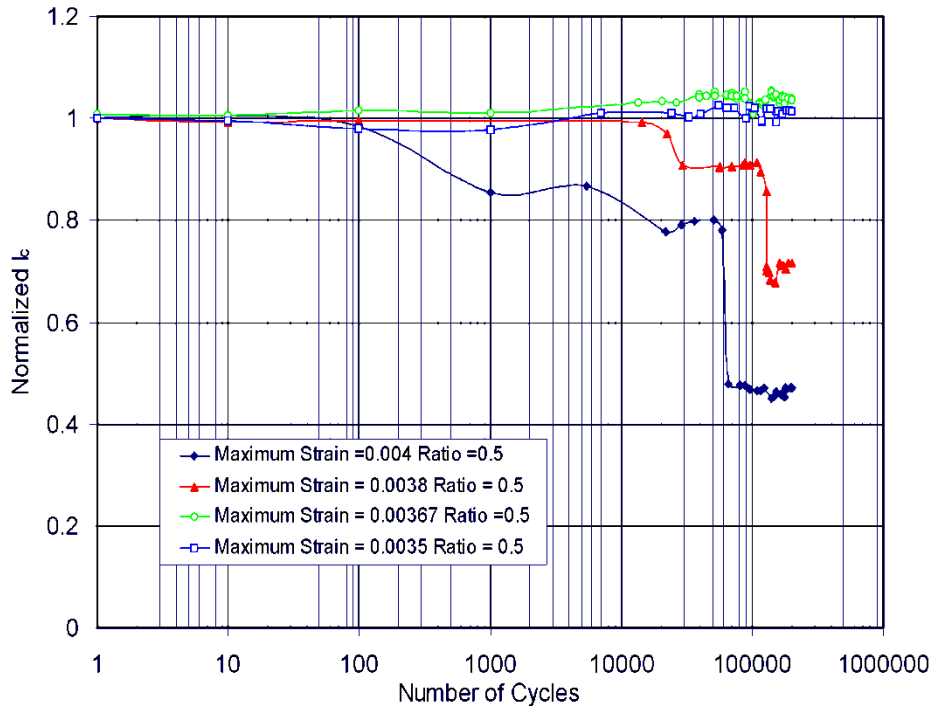
## Immediate lessons learned

- General conclusion is that there are no general conclusions
- Behaviors between different conductor types varies greatly
- Different behavior for  $B||ab$  and  $B||c \rightarrow$  field orientation matters
- Strain dependence depends on  $|B|$
- Location ( $\epsilon_m$ ) of the peak in  $I_c(\epsilon)$  depends on magnetic field  $\rightarrow$  **NOT** simply prestrain!

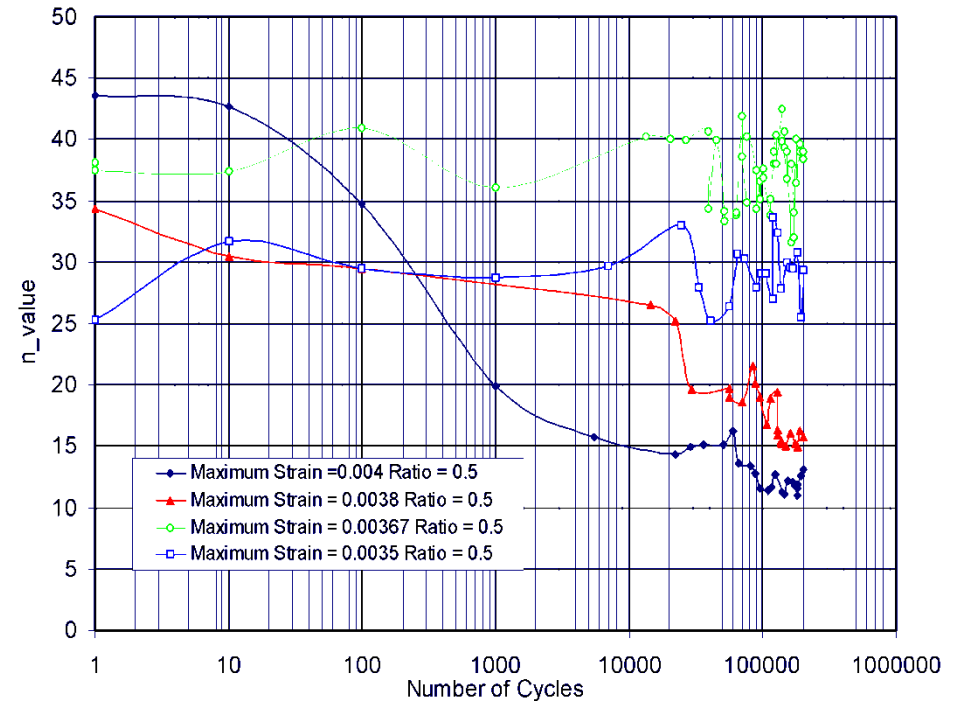
## What about fatigue?

- Overall – very little fatigue behavior has been measured for any HTS conductor
- One study looked at SuperPower tape
  - Strain controlled fatigue  $I_c$  tests
  - Strain ratios 0.5 and 0.2 at different  $\epsilon_{\max}$
- 2004-06; conductor availability limited at that time & not of same quality as today
- Fatigue testing is time and conductor intensive

# Strain-controlled fatigue R=0.5 @ 0.4 Hz



Normalized  $I_c$  versus N (log scale)

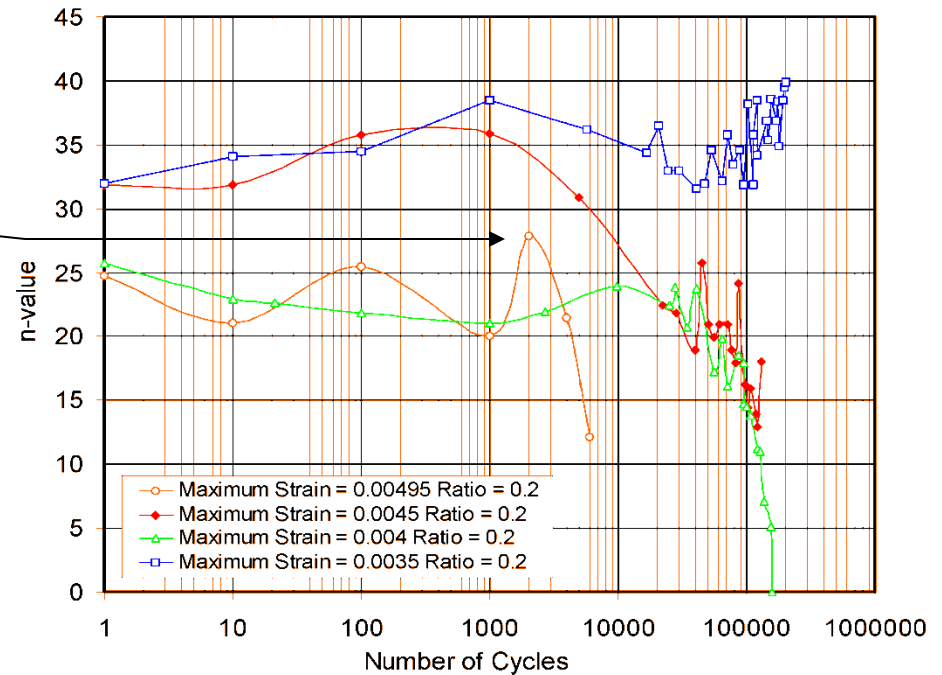
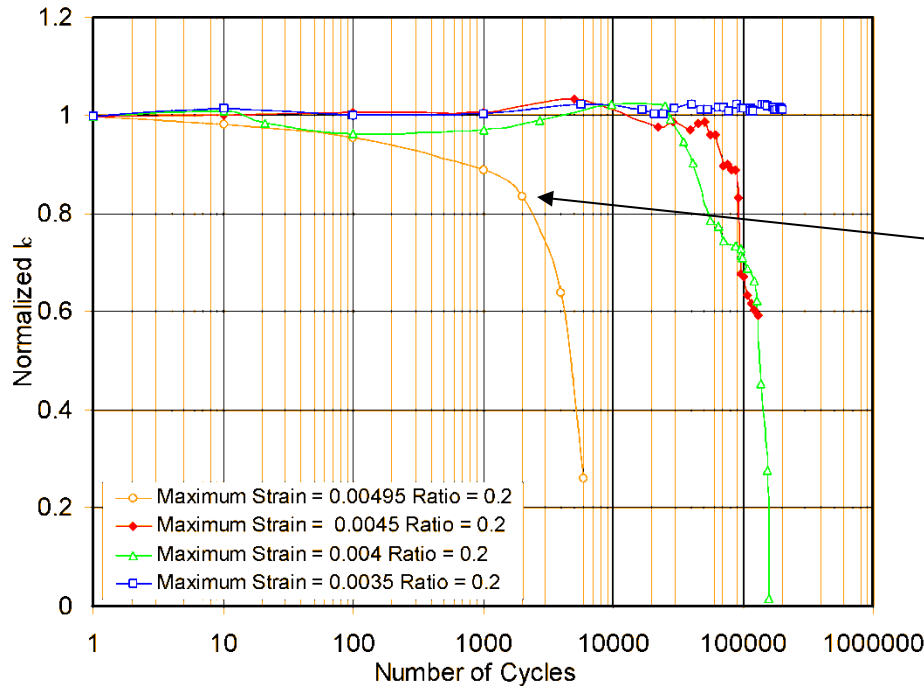


n-value versus N (log scale)

- No  $I_c$  or n-value degradation for  $\epsilon_{max} = 0.35\%$  and  $0.367\%$
- $I_c$  & n-value degradation for  $\epsilon_{max} = 0.38\%$  and  $0.40\%$
- $I_c$  degradation step-like

A.L. Mbaruku, U.P. Trociewitz and J. Schwartz, *IEEE Trans. Appl. Supercond.* **15** (2005) & A.L. Mbaruku, Ph.D. dissertation, FSU 2006

# Strain-controlled fatigue R=0.2 @ 0.4 Hz



Normalized  $I_c$  versus N (log scale)

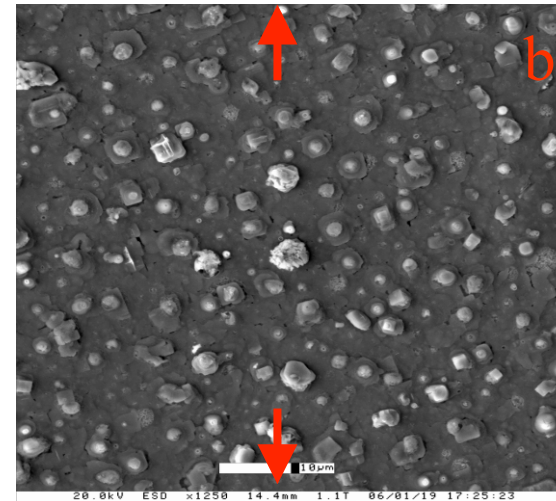
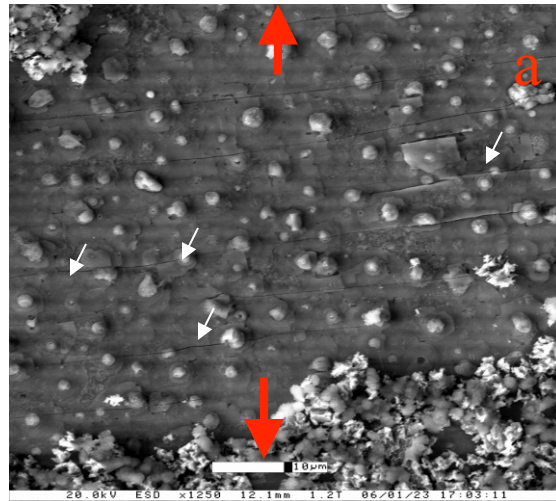
n-value versus N (log scale)

- No  $I_c$  or n-value degradation for  $\epsilon_{max} = 0.35\%$
- $I_c$  & n-value degradation for  $\epsilon_{max} = 0.40\%$  and above
- R-dependence significant
  - Degradation not step-like
- High N: n-value increases precede  $I_c$  decreases
- Strain-field induced pinning



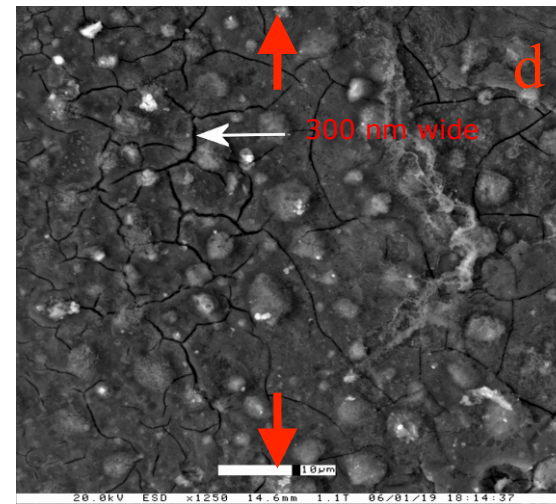
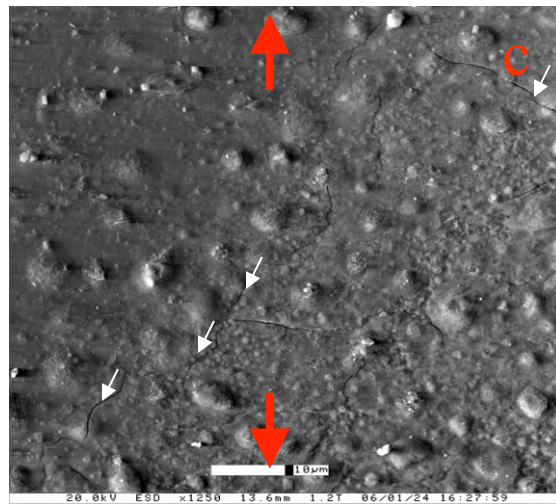
# SEM of fatigued samples

single cycle  $\sigma$ - $\epsilon$  to failure (3.1%);  
very fine cracks



typical non-cracked area from samples **with and w/out  $I_c$  degradation**  
0.45%, R=0.2

fatigue cracks on partially failed sample  
0.38%, R=0.5



fatigue cracks on completely failed sample;  
0.45%, R=0.5

intergranular/  
grain  
boundary or  
crack  
bridging?

Cracks initiate @ edge and propagate inward:  
Stress concentration factor or defect driven?

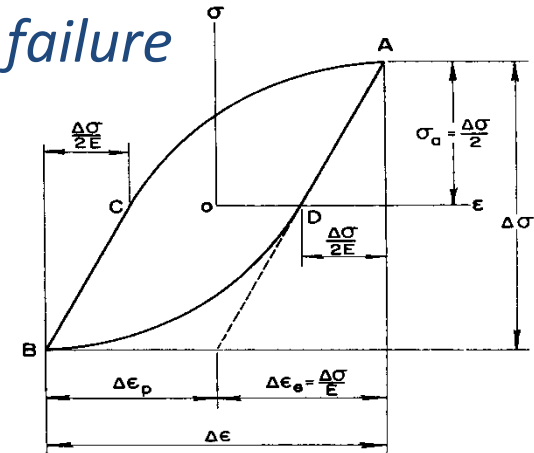
Lecture 4

# Fatigue loading effects results

*Classical analysis with electrical definition of failure*

Basquin equation  $\sigma_a = \frac{\Delta\sigma}{2} = \sigma'_f (2N_f)^b$

Coffin-Manson equation  $\frac{\Delta\varepsilon_p}{2} = \varepsilon'_f (2N_f)^c$



$2N_f =$  # of reversals to failure where  $I_c(N_f) = 0.95I_c(N=0)$

$\sigma'_f =$  fatigue strength coefficient = true monotonic fracture stress

→ indicative of HCF;  $b = (-0.04 \text{ to } -0.15 \text{ for metals})$

→ here,  $b = -0.0855$  is obtained → metallic behavior

→ **HCF controlled by Hastelloy behavior**

$\varepsilon'_f =$  fatigue ductility coefficient = true monotonic fracture strain

→ indicative of LCF;  $c = (-0.3 \text{ to } -1.0 \text{ for metals})$

→ here,  $c = -0.1103$  is obtained → non-metallic behavior

→ **LCF controlled by YBCO, BL and/or interfacial behavior**

# Delamination due to transverse loads

- REBCO CC is strong axially where Ni-alloy dominates
- Transverse strength is low → delamination at
  - Buffer layer/Ni-alloy interface
  - REBCO/buffer layer interface
  - REBCO/Ag interface
- Important for epoxy impregnation and for magnets with complex mechanical loads
- Important for quench protection, our final topic!

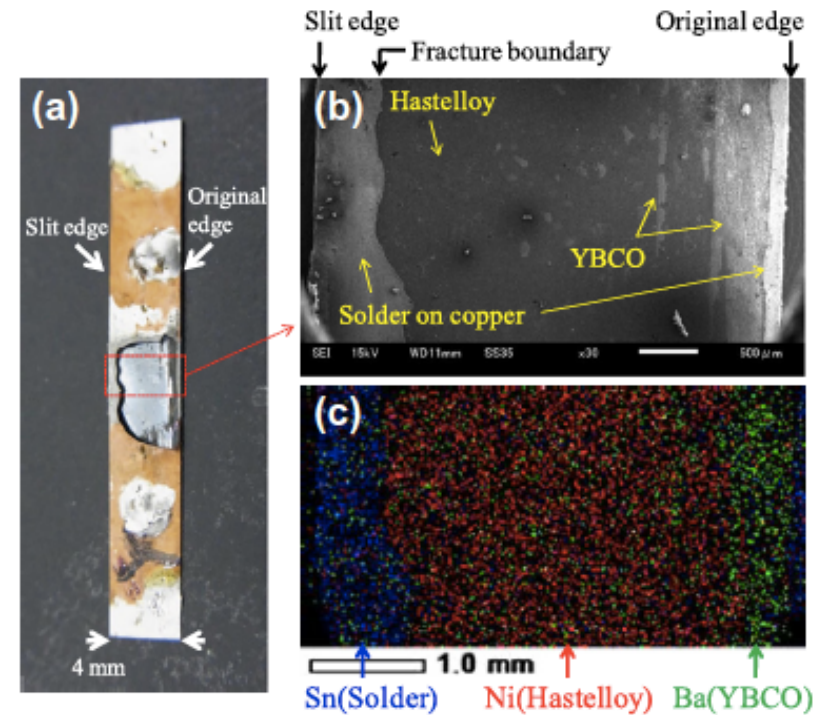


Image from Yanagisawa et al., Physica C 471 (2011) 480–485